奇美電子
CHIMEI INNOLUX

PRODUCT SPECIFICATION

□ Tentative Specification
□ Preliminary Specification
▪ Approval Specification

MODEL NO.: V546HK3

SUFFIX: LS1

Ver. C5

Customer:

APPROVED BY SIGNATURE

Name / Title

Note

Please return 1 copy for your confirmation with your signature and comments.

Approved By	Checked By	Prepared By
Chao-Chun Chung	Ken Wu	YI-CHEN Chiang

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REVISION HISTORY

Version	Date	Page (New)	Section	Description
0.0	Oct. 14,11	all	all	Tentative Specification Ver 0.0 was first issued.
1.0	Nov.10,11	all	all	Preliminary Specification Ver1.0 was first issued.
1.1	Dec.22,11	9 36 47	3.1 7.2 12	Update electrical characteristic Update optical specification Update mechanical characteristic
2.0	Feb.07,12	1 13	 3.2.2	Update ver. C5 Update power supply reference diagram
2.0	Feb.29,12	12	3.2	Modify Light Bar and Converter Characteristic
2.1	May.02,12	14	3.2.3	Modify Converter Interface Characteristic.

1. GENERAL DESCRIPTION

1.1 OVERVIEW

V546HK3-LS1 is a 54.6" TFT Liquid Crystal Display module with LED Backlight unit and 2ch-LVDS interface. This module supports 1920 x 1080 HDTV format and can display true 16.7M colors (10-bit). The driving board module for backlight is built-in.

1.2 FEATURES

- High brightness 350nits
- High contrast ratio 5000:1
- Fast response time Gray to Gray typical 6ms
- High color saturation 72% NTSC
- Full HDTV (1920 x 1080 pixels) resolution, true HDTV format
- DE (Data Enable) only mode
- LVDS (Low Voltage Differential Signaling) interface
- Optimized response time for 120 Hz frame rate
- Ultra wide viewing angle: Super MVA technology
- RoHs compliance

1.3 APPLICATION

- Standard Living Room TVs.
- Public Display Application.
- Home Theater Application.
- MFM Application.

1.4 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Active Area	1209.6(H) x 680.4(V) (54.6" diagonal)	mm	(1)
Bezel Opening Area	1217.6 (H) x 688.4 (V)	mm	
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920x R.G.B. x 1080	pixel	-
Pixel Pitch(Sub Pixel)	0.21(H) x 0.63(V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	16.7M	color	-
Display Operation Mode	Transmissive mode / Normally black	-	-
Surface Treatment	Anti-Glare coating (Haze 3.5%),Hardness 3H	-	(2)

Note (1) Please refer to the attached drawings in chapter 9 for more information about the front and back outlines.

Note (2) Please refer sec 3.1 and 3.2 for more information of Power consumption

Note (3) The spec of the surface treatment is temporarily for this phase. CMI reserves the rights to change this feature.

1.5 MECHANICAL SPECIFICATIONS

Item		Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	1235.9	1237.4	1238.9	mm	Module Size
	Vertical (V)	709.8	711.3	712.8	mm	
	Depth (D)	16.4	18.4	19.4	mm	To Rear
		23	24	25	mm	To converter cover
Weight	Weight	16300	16800	17200	g	Weight

Note (1)Please refer to the attached drawings for more information of front and back outline dimensions.

Note (2) Module Depth does not include connectors.

2. ABSOLUTE MAXIMUM RATINGS

2.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol		Value		Unit	Note
			Min.	Max.		
Storage Temperature	T_{ST}		-20	+60	°C	(1)
Operating Ambient Temperature	T_{OP}		0	50	°C	(1), (2)
Shock (Non-Operating)	S_{NOP}	X, ±Y	-	30	G	(3), (5)
		±Z		30		
Vibration (Non-Operating)	V_{NOP}		-	1.0	G	(4), (5)

Note (1) Temperature and relative humidity range is shown in the figure below.

(a) 90 %RH Max. (Ta ≦ 40 C).

(b) Wet-bulb temperature should be 39 C Max. (Ta > 40 C).

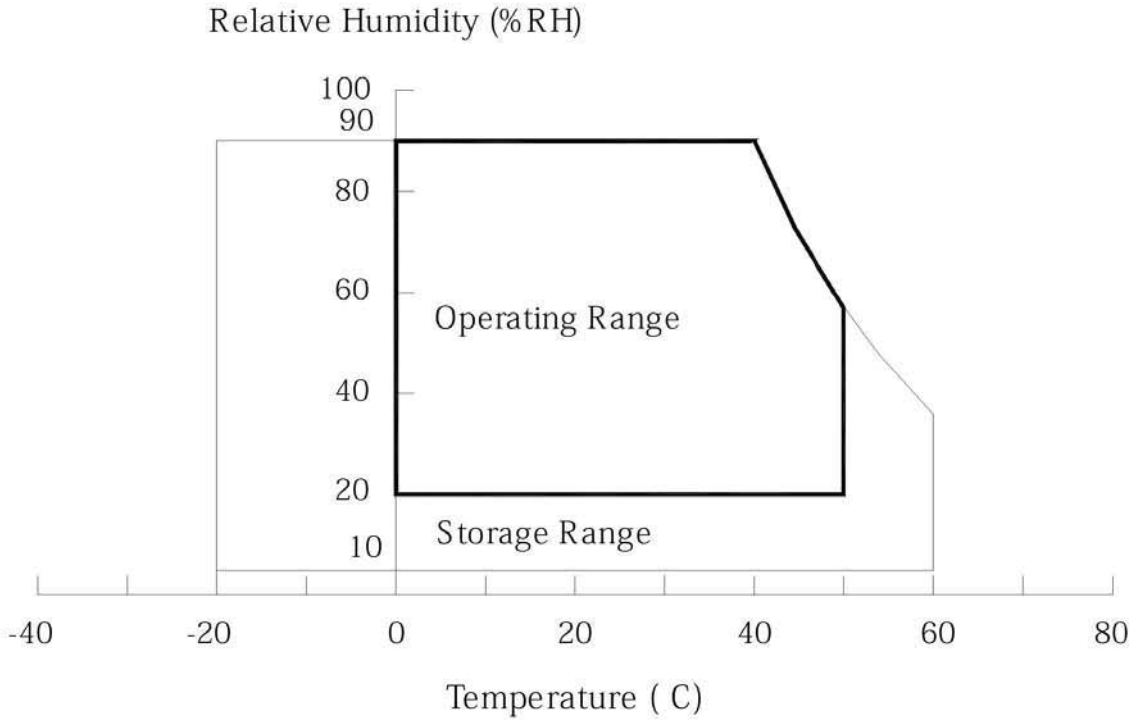
(c) No condensation.

Note (2) The maximum operating temperature is based on the test condition that the surface temperature of display area is less than or equal to 65 C with LCD module alone in a temperature controlled chamber. Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 65 C. The range of operating temperature may degrade in case of improper thermal management in final product design.

Note (3) 11 ms, half sine wave, 1 time for ? X, Y, ? Z.

Note (4) 10 ~ 200 Hz, 10 min, 1 time each X, Y, Z.

Note (5) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.



2.2 ELECTRICAL ABSOLUTE RATINGS

2.2.1 TFT LCD MODULE

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	V_{CC}	-0.3	13.5	V	(1)
Logic Input Voltage	V_{IN}	-0.3	3.6	V	

2.2.2 BACKLIGHT CONVERTER UNIT

Item	Symbol	Test Condition	Min.	Type	Max.	Unit	Note
Light Bar Voltage	V_W	Ta = 25 ℃	-	-	60	V_{RMS}	3D Mode
Converter Input Voltage	V_{BL}	-	0	-	30	V	
Control Signal Level	-	-	-0.3	-	6	V	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note (2) No moisture condensation or freezing.

Note (3) The control signals include On/Off Control and External PWM Control.

3. ELECTRICAL CHARACTERISTICS

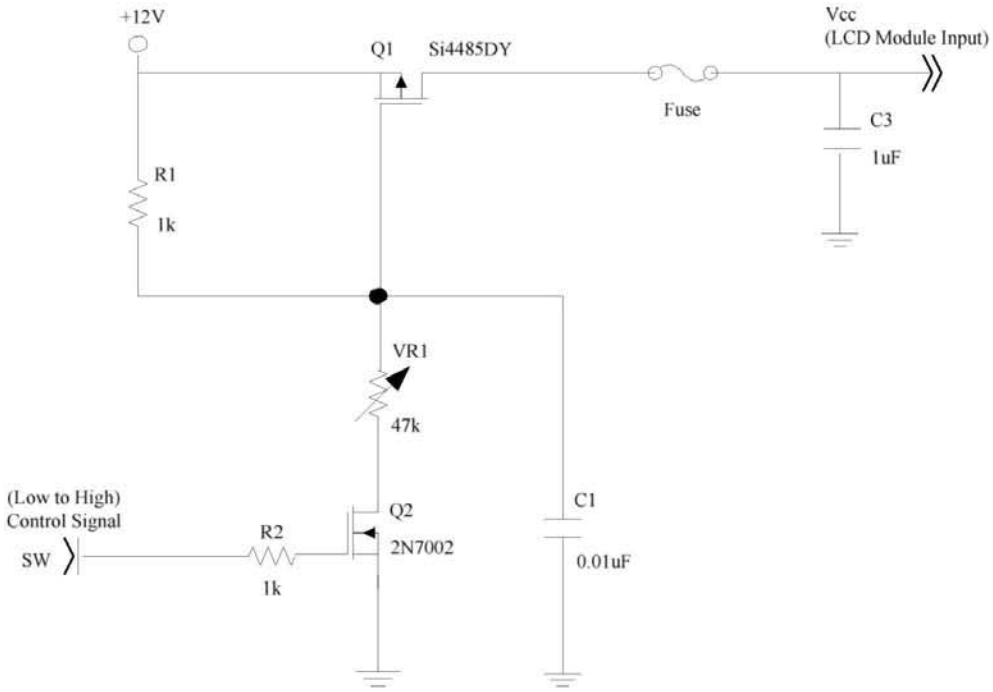
3.1 TFT LCD MODULE

(Ta = 25 2 C)

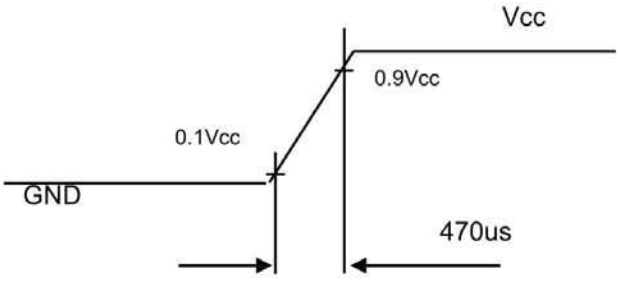
Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Power Supply Voltage		V_{CC}	10.8	12	13.2	V	(1)
Rush Current		I_{RUSH}	—	—	2.67	A	(2)
Power Consumption	White Pattern	—	—	9.36	11.52	W	(3)
	Horizontal Stripe	—	—	19.92	24	W	
	Black Pattern	—	—	8.88	10.8	W	
Power Supply Current	White Pattern	—	—	0.78	0.96	A	
	Horizontal Stripe	—	—	1.66	2	A	
	Black Pattern	—	—	0.74	0.9	A	
LVDS interface	Differential Input High Threshold Voltage	V_{LVTH}	+100	—	—	mV	(4)
	Differential Input Low Threshold Voltage	V_{LVTL}	—	—	-100	mV	
	Common Input Voltage	V_{CM}	1.0	1.2	1.4	V	
	Differential input voltage (single-end)	$\|V_{ID}\|$	200	—	600	mV	
	Terminating Resistor	R_T	—	100	—	ohm	
CMIS interface	Input High Threshold Voltage	V_{IH}	2.7	—	3.3	V	
	Input Low Threshold Voltage	V_{IL}	0	—	0.7	V	

Note (1) The module should be always operated within the above ranges.

Note (2) Measurement condition:



Vcc rising time is 470us



Note (3) The specified power consumption and power supply current is under the conditions at Vcc = 12 V, Ta = 25 2 C, f_v = 120 Hz, whereas a power dissipation check pattern below is displayed.

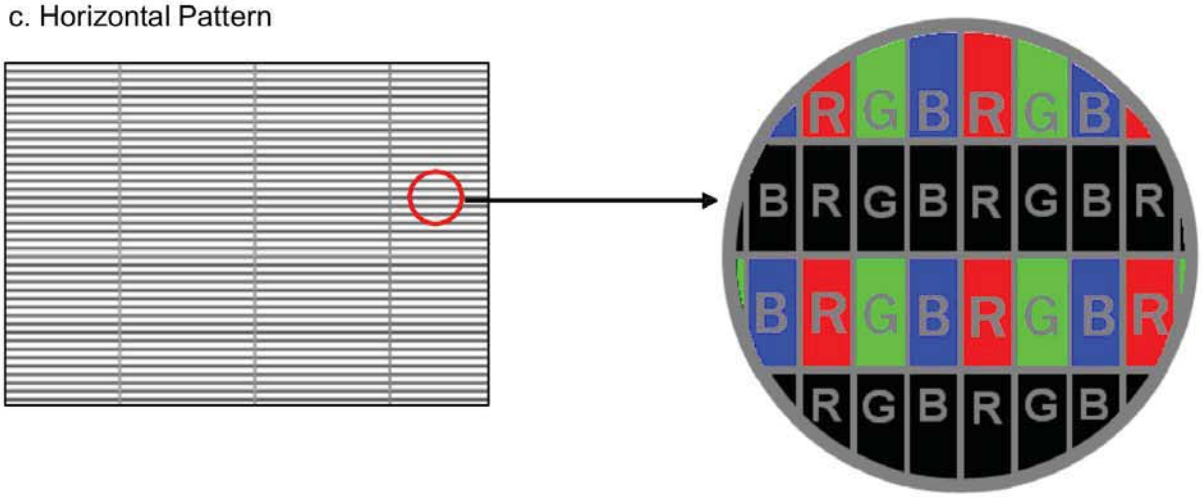
a. White Pattern

Active Area

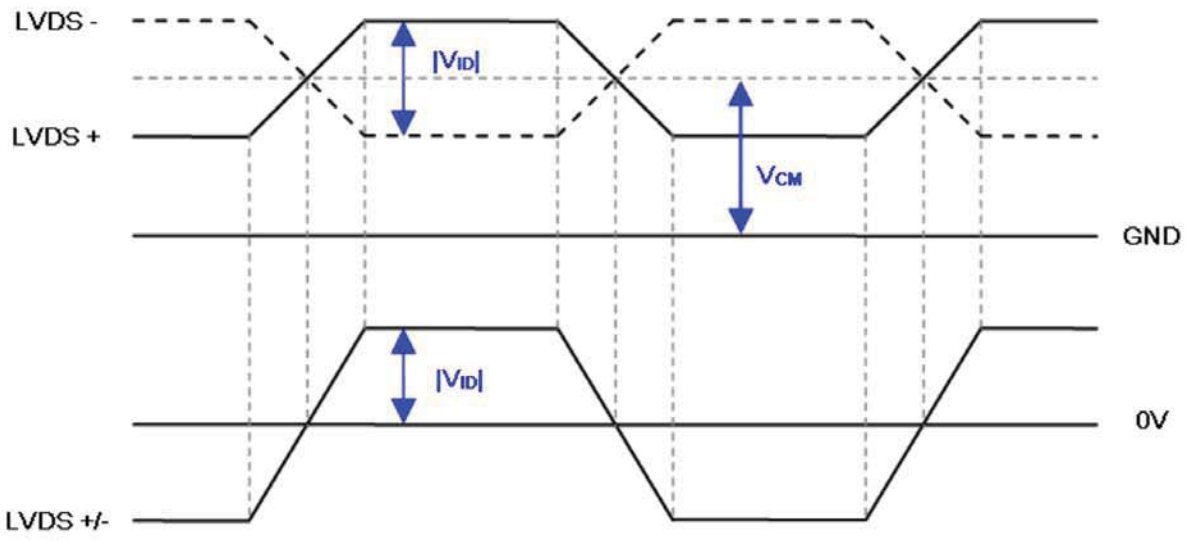
b. Black Pattern

Active Area

c. Horizontal Pattern



Note (4) The LVDS input characteristics are as follows:



3.2 BACKLIGHT UNIT

3.2.1 LED LIGHT BAR CHARACTERISTICS (Ta = 25 ± 2 °C)

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Total Current (16 String)	If	-	1840	1950.4	mA	
One String Current	$I_{L(2D)}$	-	115	121.9	mA	
	$I_{L(3D)}$	-	450	477	mApeak	3D ENA=ON
LED Forward Voltage	V_f	5.7	6.1	6.4	V_{DC}	I_L =115mA
One String Voltage	V_W	45.6	-	51.2	V_{DC}	I_L =115mA
One String Voltage Variation	$\triangle V_W$	-	-	2	V	
Life time	-	30,000	-	-	Hrs	(1)

Note (1) The lifetime is defined as the time which luminance of the LED decays to 50% compared to the initial value, Operating condition: Continuous operating at Ta = 25 ± 2℃, I_L =115mA.

3.2.2 CONVERTER CHARACTERISTICS (Ta = 25 ± 2 °C)

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Power Consumption	$P_{BL(2D)}$	-	100	115	W	(1), (2) IL = 115 mA
	$P_{BL(3D)}$	-	97.3	114	W	(1), (2) IL=450mA.
Converter Input Voltage	VBL	22.8	24.0	25.2	VDC	
Converter Input Current	$I_{BL(2D)}$	-	4.17	4.79	A	Non Dimming
	$I_{BL(3D)}$	-	4	4.75	A	
Input Inrush Current	$I_{R(2D)}$	-	-	6.49	Apeak	V_{BL}=22.8V,(IL=typ.) (3), (6)
	$I_{R(3D)}$	-	-	11	Apeak	V_{BL}=22.8V,(IL= 450mA.)(3), (6)
Dimming Frequency	FB	150	160	170	Hz	(5)
Minimum Duty Ratio	DMIN	5	10	-	%	(4), (5)

Note (1) The power supply capacity should be higher than the total converter power consumption P_{BL}. Since the pulse width modulation (PWM) mode was applied for backlight dimming, the driving current changed as PWM duty on and off. The transient response of power supply should be considered for the changing loading when converter dimming.

Note (2) The measurement condition of Max. value is based on 55" backlight unit under input voltage 24V, average LED current 121.9mA at 2D Mode (LED current 477 mA_{peak} at 3D Mode) and lighting 1 hour later.

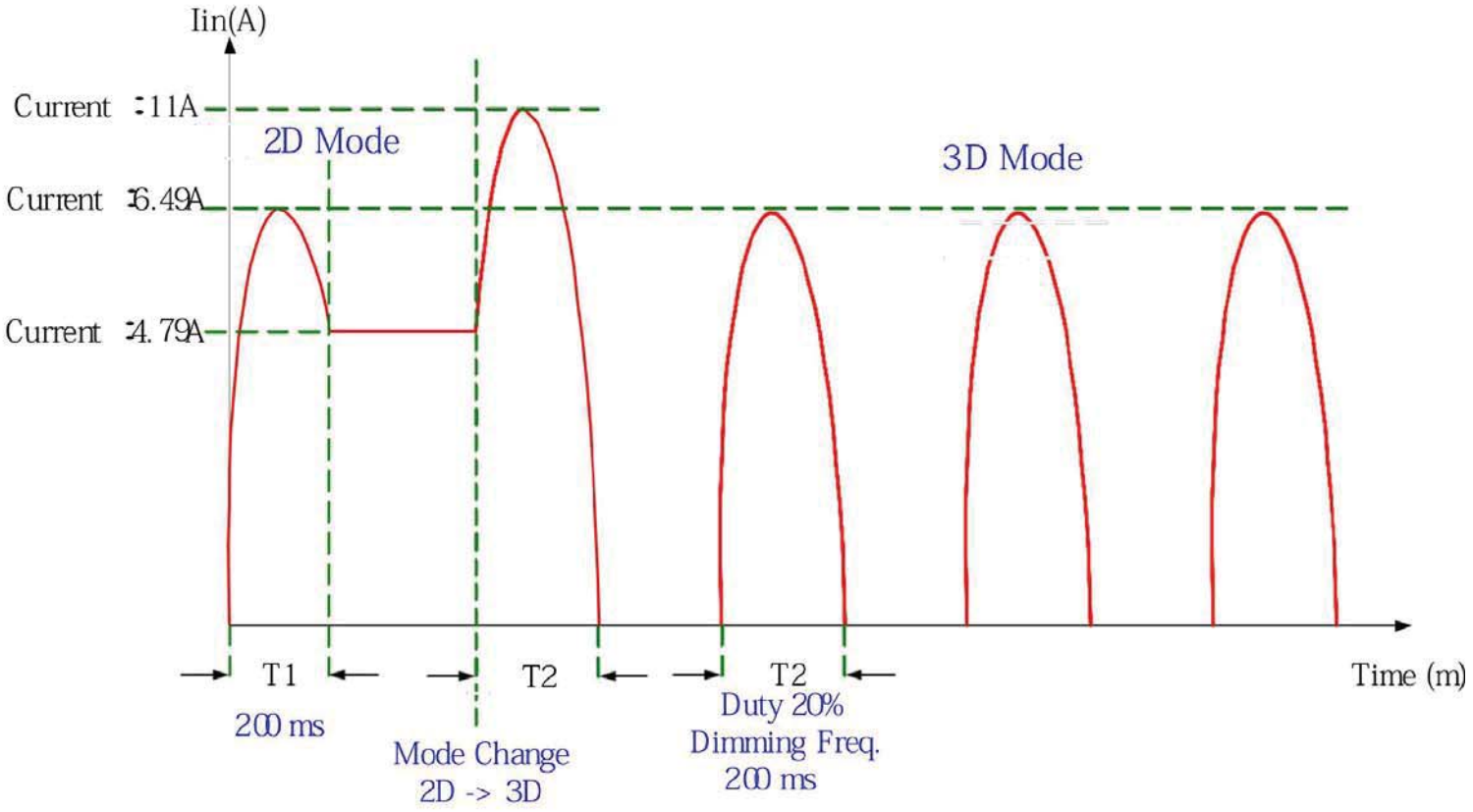
Note (3) For input inrush current measure, the VBL rising time from 10% to 90% is about 30ms.

Note (4) 5% minimum duty ratio is only valid for electrical operation.

Note (5) FB and DMIN are available only at 2D Mode.

Note (6) Below diagram is only for power supply design reference.

Test Condition: V_{BL}=22.8V, IL=115mA at 2D Mode/ IL=(450)mA peak at 3D Mode



3.2.3 CONVERTER INTERFACE CHARACTERISTICS

Parameter		Symbol	Test Conditio	Value			Unit	Note	
				Min.	Typ.	Max.			
On/Off Control Voltage	ON	VBLON	—	2.0	—	5.5	V		
	OFF		—	0	—	0.8	V		
External PWM Control Voltage	HI	VEPWM	—	2.0	—	5.25	V	Duty on	(5), (6)
	LO		—	0	—	0.8	V	Duty off	
External PWM Contril Frequency		FEPWM	—	150	160	170	Hz	Normal mode	
Error Signal		ERR	—	—	—	—	—	Abnormal: Open collector Normal: GND (4)	
VBL Rising Time		Tr1	—	30	—	—	ms	10%-90%V_{BL}	
Control Signal Rising Time		Tr	—	—	—	100	ms		
Control Signal Falling Time		Tf	—	—	—	100	ms		
PWM Signal Rising Time		TP	—	—	—	50	us	(6)	
PWM Signal Falling Time		TP	—	—	—	50	us		
Input Impedance		Rin	—	1	—	—	MΩ	EPWM, BLON	
PWM Delay Time		TPWM	—	100	—	—	ms	(6)	
BLON Delay Time		T_{on}	—	300	—	—	ms		
		T_{on1}	—	300	—	—	ms		
BLON Off Time		Toff	—	300	—	—	ms		

Note (1) The Dimming signal should be valid before backlight turns on by BLON signal. It is inhibited to change the external PWM signal during backlight turn on period.

Note (2) The power sequence and control signal timing are shown in the Fig.1. For a certain reason, the converter has a possibility to be damaged with wrong power sequence and control signal timing.

Note (3) While system is turned ON or OFF, the power sequences must follow as below descriptions:

Turn ON sequence: VBL → PWM signal → BLON

Turn OFF sequence: BLOFF → PWM signal → VBL

Note (4) When converter protective function is triggered, ERR will output open collector status.

Note (5) The EPWM interface that inserts a pull up resistor to 5V in Max Duty (100%), please refers to Fig.2.

Note (6) EPWM is available only at 2D Mode.

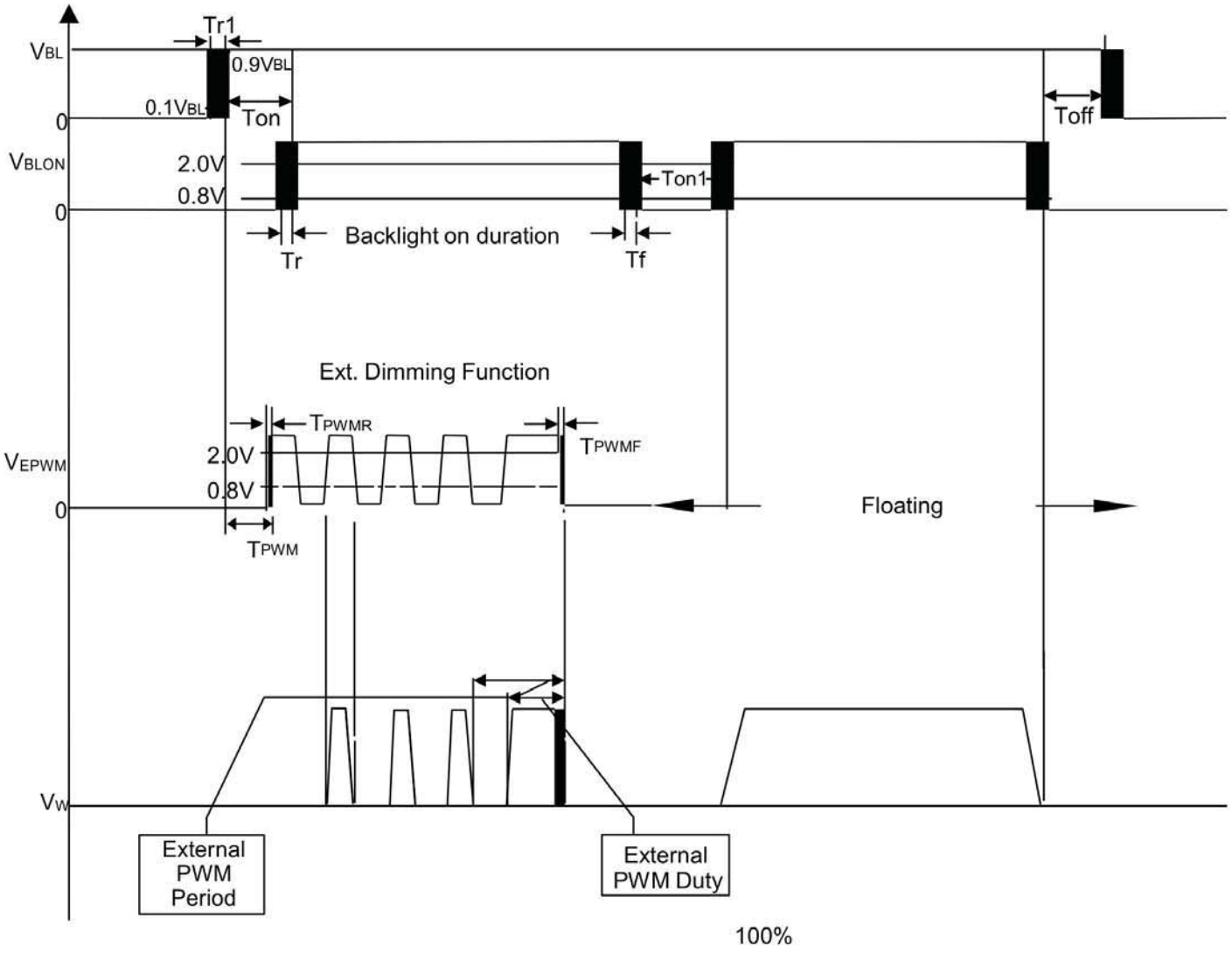


Fig. 1

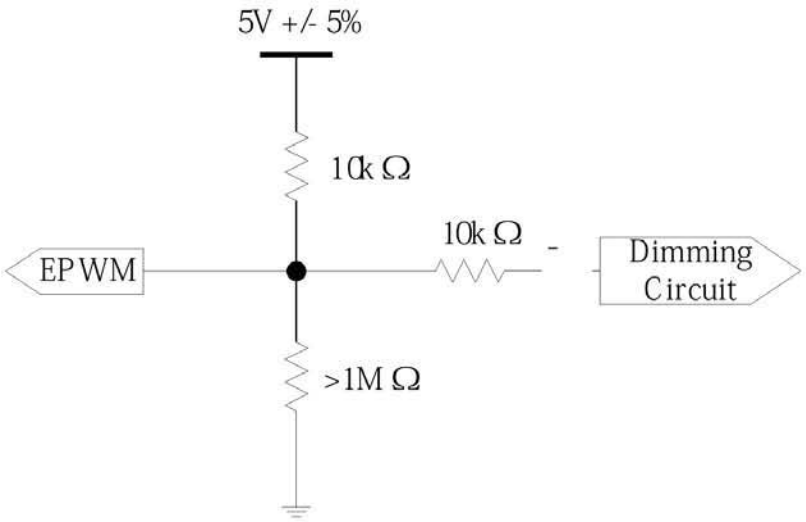
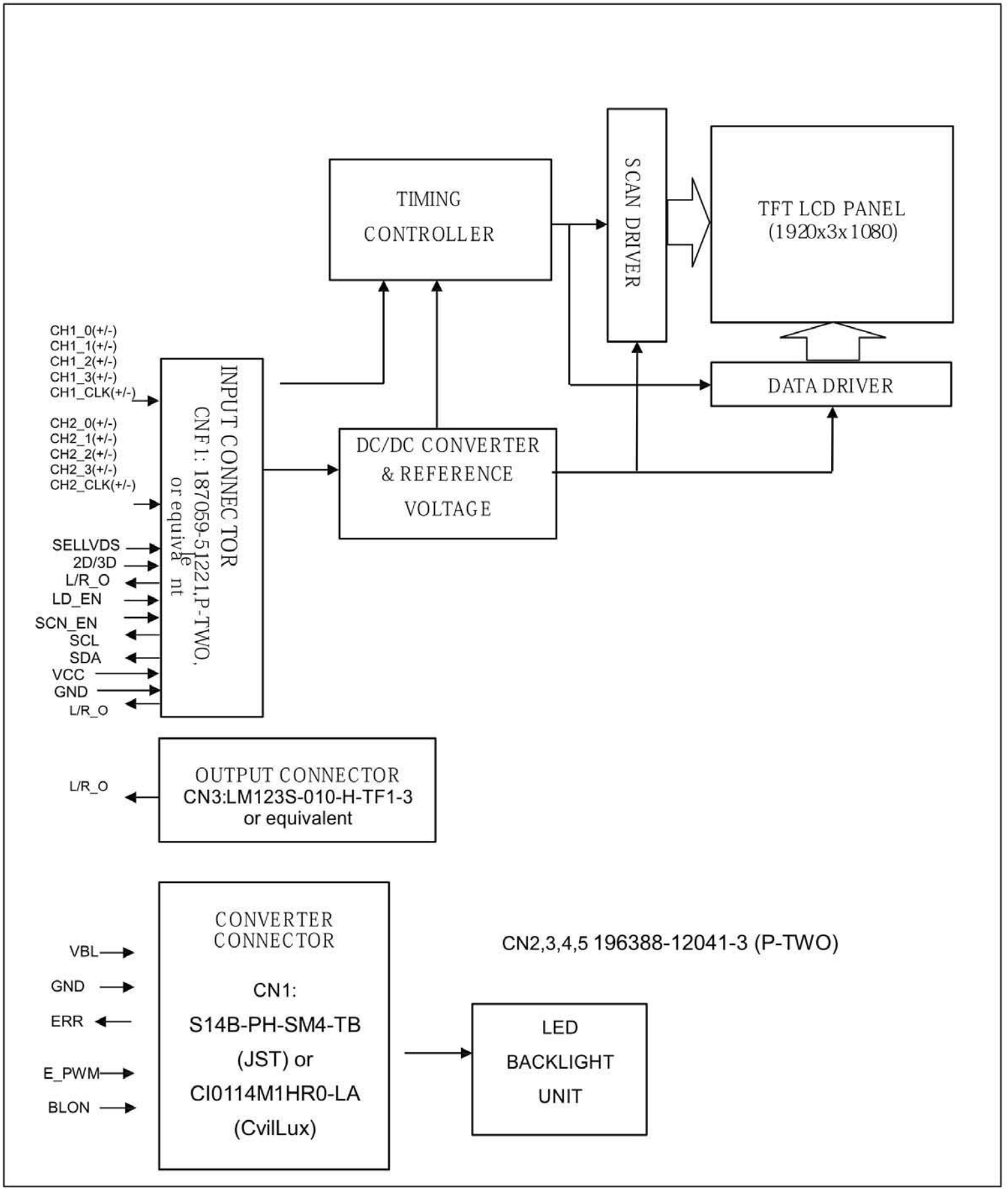


Fig. 2

4. BLOCK DIAGRAM OF INTERFACE

4.1 TFT LCD MODULE



5 .INPUT TERMINAL PIN ASSIG NMENT

5.1 TFT LCD MODULE

CNF1 Connector Pin Assignment: (FI-RE51S-HF(JAE) or equivalent)

Pin	Name	Description	Note
1	N.C.	No Connection	(1)
2	SCL	EEPROM Serial Clock (for local dimming demo function)	(5)
3	SDA	EEPROM Serial Data (for local dimming demo function)	
4	NC	No Connection	1
5	NC	No Connection	
6	N.C.	No Connection	(1)
7	SELLVDS	LVDS Data Format Selection	(2)(3)
8	N.C.	No Connection	(1)
9	N.C.	No Connection	
10	N.C.	No Connection	
11	GND	Ground	
12	CH1[0]-	First pixel Negative LVDS differential data input. Pair 0	(4)
13	CH1[0]+	First pixel Positive LVDS differential data input. Pair 0	
14	CH1[1]-	First pixel Negative LVDS differential data input. Pair 1	
15	CH1[1]+	First pixel Positive LVDS differential data input. Pair 1	
16	CH1[2]-	First pixel Negative LVDS differential data input. Pair 2	
17	CH1[2]+	First pixel Positive LVDS differential data input. Pair 2	
18	GND	Ground	
19	CH1CLK-	First pixel Negative LVDS differential clock input.	(4)
20	CH1CLK+	First pixel Positive LVDS differential clock input.	
21	GND	Ground	
22	CH1[3]-	First pixel Negative LVDS differential data input. Pair 3	(4)
23	CH1[3]+	First pixel Positive LVDS differential data input. Pair 3	
24	CH1[4]-	First pixel Negative LVDS differential data input. Pair 4	
25	CH1[4]+	First pixel Positive LVDS differential data input. Pair 4	
26	GND	Ground	
27	NC	No Connection	
28	CH2[0]-	Second pixel Negative LVDS differential data input. Pair 0	(4)

29	CH2[0]+	Second pixel Positive LVDS differential data input. Pair 0	(4)
30	CH2[1]-	Second pixel Negative LVDS differential data input. Pair 1	
31	CH2[1]+	Second pixel Positive LVDS differential data input. Pair 1	
32	CH2[2]-	Second pixel Negative LVDS differential data input. Pair 2	
33	CH2[2]+	Second pixel Positive LVDS differential data input. Pair 2	
34	GND	Ground	
35	CH2CLK-	Second pixel Negative LVDS differential clock input.	(4)
36	CH2CLK+	Second pixel Positive LVDS differential clock input.	
37	GND	Ground	
38	CH2[3]-	Second pixel Negative LVDS differential data input. Pair 3	(4)
39	CH2[3]+	Second pixel Positive LVDS differential data input. Pair 3	
40	CH2[4]-	Second pixel Negative LVDS differential data input. Pair 4	
41	CH2[4]+	Second pixel Positive LVDS differential data input. Pair 4	
42	NC	No Connection	(5)(3)
43	GND	Ground	
44	GND	Ground	
45	GND	Ground	
46	GND	Ground	
47	N.C.	No Connection	(1)
48	VCC	+12V power supply	
49	VCC	+12V power supply	
50	VCC	+12V power supply	
51	VCC	+12V power supply	

CNF2 Connector Pin Assignment (FI-RE41S-HF (JAE) or equivalent)

Pin	Name	Description	Note
1	N.C.	No Connection	(1)
2	N.C.	No Connection	
3	N.C.	No Connection	
4	N.C.	No Connection	
5	N.C.	No Connection	
6	N.C.	No Connection	
7	N.C.	No Connection	
8	N.C.	No Connection	
9	GND	Ground	
10	CH3[0]-	Third pixel Negative LVDS differential data input. Pair 0	(4)
11	CH3[0]+	Third pixel Positive LVDS differential data input. Pair 0	
12	CH3[1]-	Third pixel Negative LVDS differential data input. Pair 1	
13	CH3[1]+	Third pixel Positive LVDS differential data input. Pair 1	
14	CH3[2]-	Third pixel Negative LVDS differential data input. Pair 2	
15	CH3[2]+	Third pixel Positive LVDS differential data input. Pair 2	
16	GND	Ground	
17	CH3CLK-	Third pixel Negative LVDS differential clock input.	(4)
18	CH3CLK+	Third pixel Positive LVDS differential clock input.	
19	GND	Ground	
20	CH3[3]-	Third pixel Negative LVDS differential data input. Pair 3	(4)
21	CH3[3]+	Third pixel Positive LVDS differential data input. Pair 3	
22	CH3[4]-	Third pixel Negative LVDS differential data input. Pair 4	
23	CH3[4]+	Third pixel Positive LVDS differential data input. Pair 4	
24	GND	Ground	
25	GND	Ground	
26	CH4[0]-	Fourth pixel Negative LVDS differential data input. Pair 0	(4)
27	CH4[0]+	Fourth pixel Positive LVDS differential data input. Pair 0	
28	CH4[1]-	Fourth pixel Negative LVDS differential data input. Pair 1	
29	CH4[1]+	Fourth pixel Positive LVDS differential data input. Pair 1	
30	CH4[2]-	Fourth pixel Negative LVDS differential data input. Pair 2	

31	CH4[2]+	Fourth pixel Positive LVDS differential data input. Pair 2	(4)
32	GND	Ground	
33	CH4CLK-	Fourth pixel Negative LVDS differential clock input.	(4)
34	CH4CLK+	Fourth pixel Positive LVDS differential clock input.	
35	GND	Ground	
36	CH4[3]-	Fourth pixel Negative LVDS differential data input. Pair 3	(4)
37	CH4[3]+	Fourth pixel Positive LVDS differential data input. Pair 3	
38	CH4[4]-	Fourth pixel Negative LVDS differential data input. Pair 4	
39	CH4[4]+	Fourth pixel Positive LVDS differential data input. Pair 4	
40	GND	Ground	
41	GND	Ground	

Note (1) Reserved for internal use. Please leave it open.

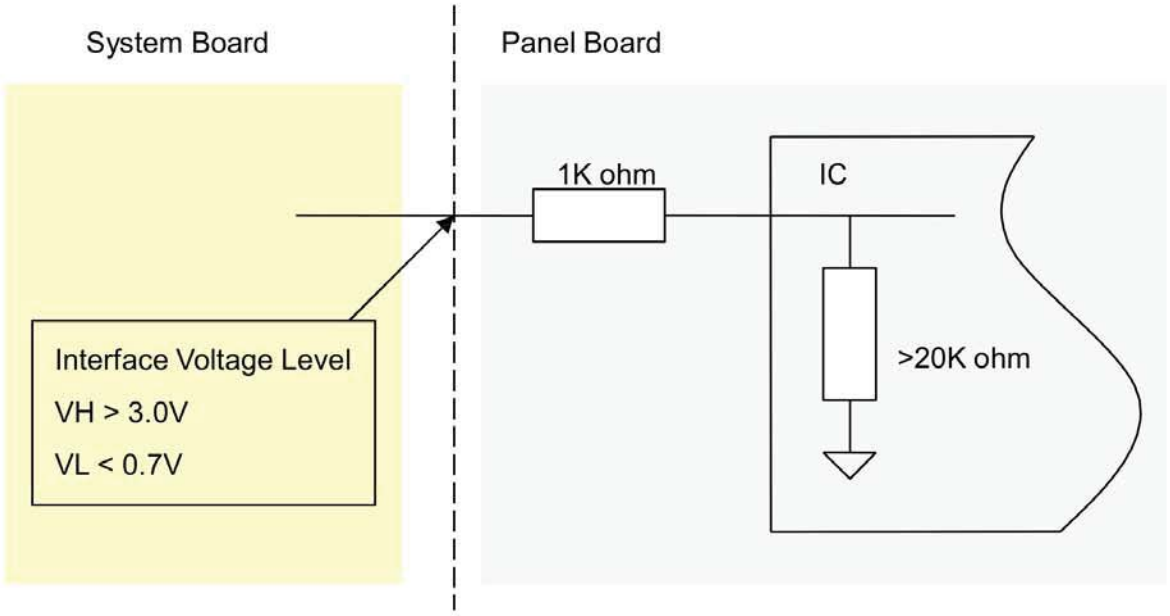
Note (2) LVDS format selection.

L= Connect to GND, H=Connect to +3.3V or open

SELLVDS	Note
L	JEIDA Format
H or Open	VESA Format

Note (3) SELLVDS signal pin connected to the LCM side has the following diagram.

R1 in the system side should be less than 1K Ohm. (R1 < 1K Ohm)

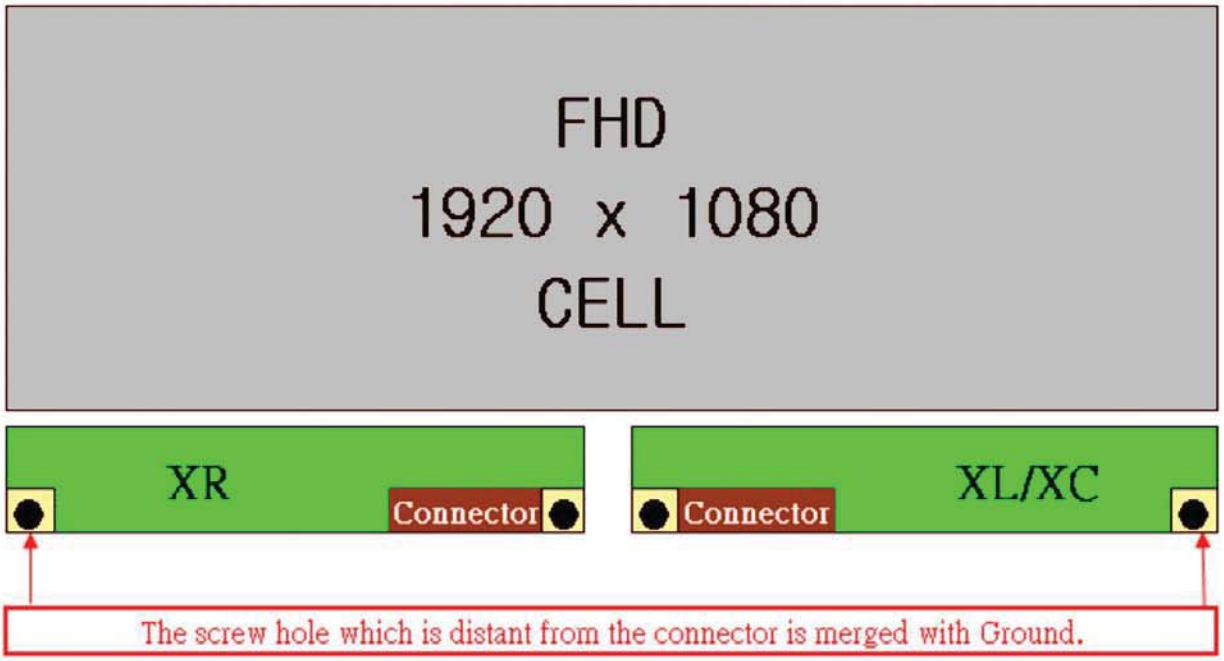


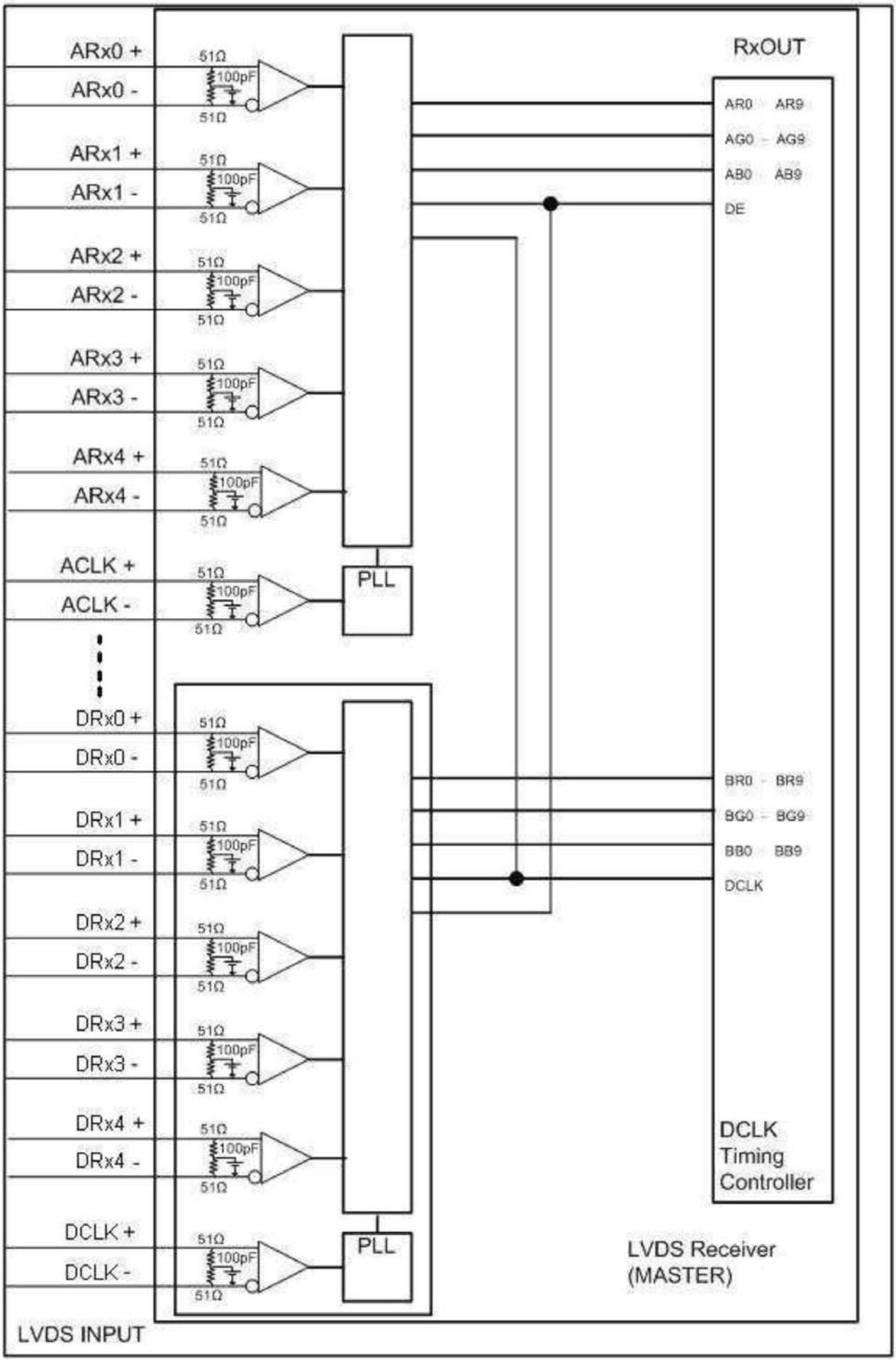
Note (4) LVDS 4-port Data Mapping

Port	Channel of LVDS	Data Stream
1st Port	First Pixel	1, 5, 9, ……1913, 1917
2nd Port	Second Pixel	2, 6, 10, ….1914, 1918
3rd Port	Third Pixel	3, 7, 11, ….1915, 1919
4th Port	Fourth Pixel	4, 8, 12, ….1916, 1920

Note (5) Please reference Appendix A

Note (6) The screw hole which is distant from the connector is merged with Ground





AR0~AR9: First pixel R data

AG0~AG9: First pixel G data

AB0~AB9: First pixel B data

BR0~BR9: Second pixel R data

BG0~BG9: Second pixel G data

BB0~BB9: Second pixel B data DE:

Data enable signal

DCLK: Data clock signal

The third and fourth pixel are followed the same rules.

CR0~CR9: Third pixel R data

CG0~CG9: Third pixel G data

CB0~CB9: Third pixel B data

DR0~DR9: Fourth pixel R data

DG0~DG9: Fourth pixel G data

DB0~DB9: Fourth pixel B data

Note (1) A ~ D channel are first, second, third and fourth pixel respectively.

Note (2) The system must have the transmitter to drive the module.

Note (3) LVDS cable impedance shall be 50 ohms per signal line or about 100 ohms per twist-pair line when it is used differentially.

The pin configuration for the housing and leader wire is shown in the table below.

CN2,3,6,7: 196388-12041-3 (P-TWO)

Pin №	Symbol	Feature
1	VLED	Positive of LED String
2	VLED	
3	VLED	
4	VLED	
5	NC	NC
6	NC	
7	NC	
8	NC	
9	N1	Negative of LED String
10	N2	
11	N3	
12	N4	

Note (1)The backlight interface housing for high voltage side is a model 51281-1094, manufactured by Molex or equivalent. The mating header on converter part number is 51281-1094

5.3 DRIVING BOARD UNIT

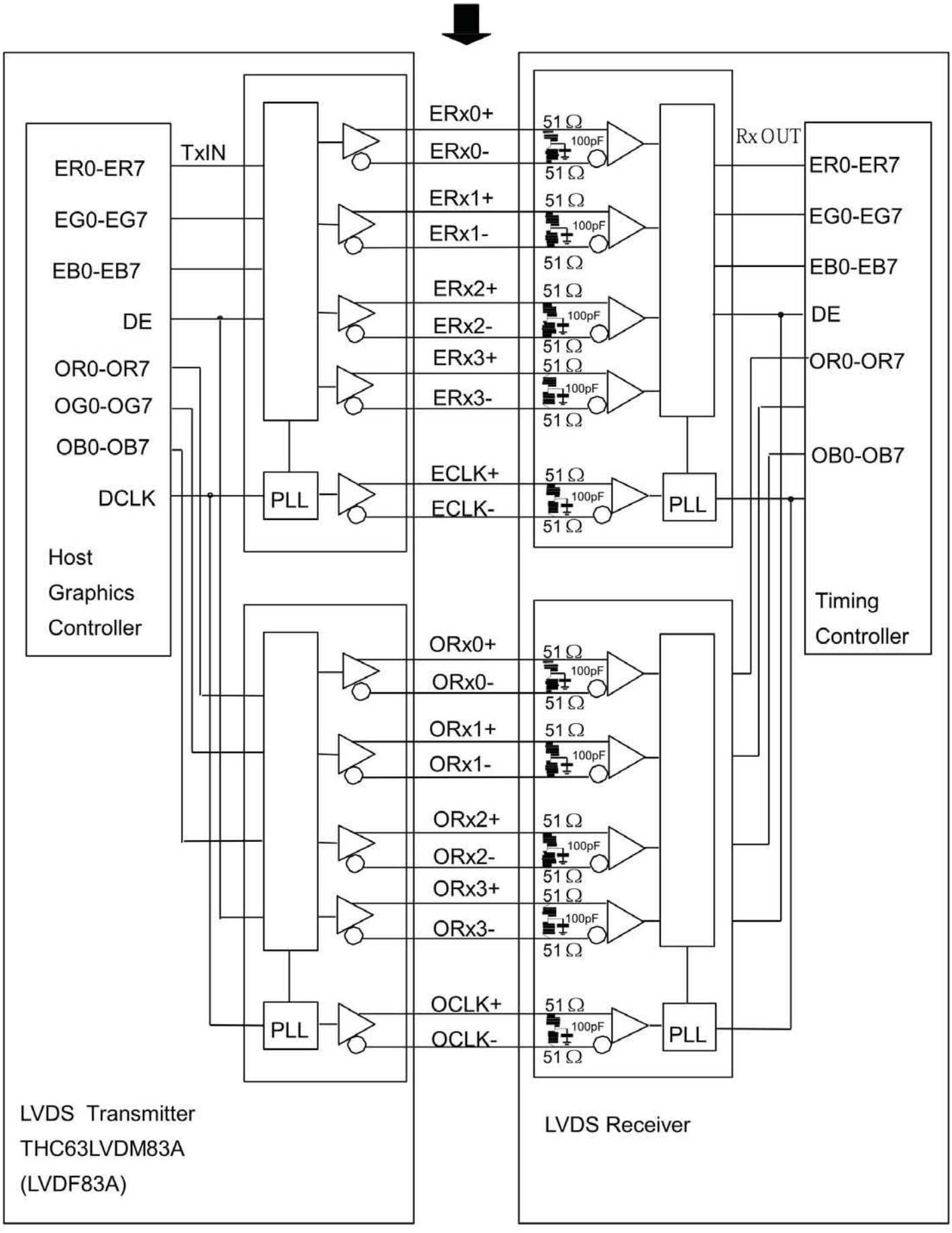
CN1(Header): S14B-PH-SM4-TB (JST) or CI0114M1HR0-LA (CvilLux)

Pin No.	Symbol	Feature
1	VBL	+24V
2		
3		
4		
5		
6	GND	GND
7		
8		
9		
10		
11	ERR	Normal (GND) Abnormal (Open
12	BLON	BL ON/OFF
13	NC	NC
14	E_PWM	External PWM Control

Notice

1. If Pin14 is open, E_PWM is 100% duty.

5.4 BLOCK DIAGRAM OF INTERFACE



ER0~ER7: Even pixel R data

EG0~EG7: Even pixel G data

EB0~EB7: Even pixel B data

OR0~OR7: Odd pixel R data

OG0~OG7: Odd pixel G data

OB0~OB7: Odd pixel B data

DE: Data enable signal

DCLK: Data clock signal

Note (1) The system must have the transmitter to drive the module.

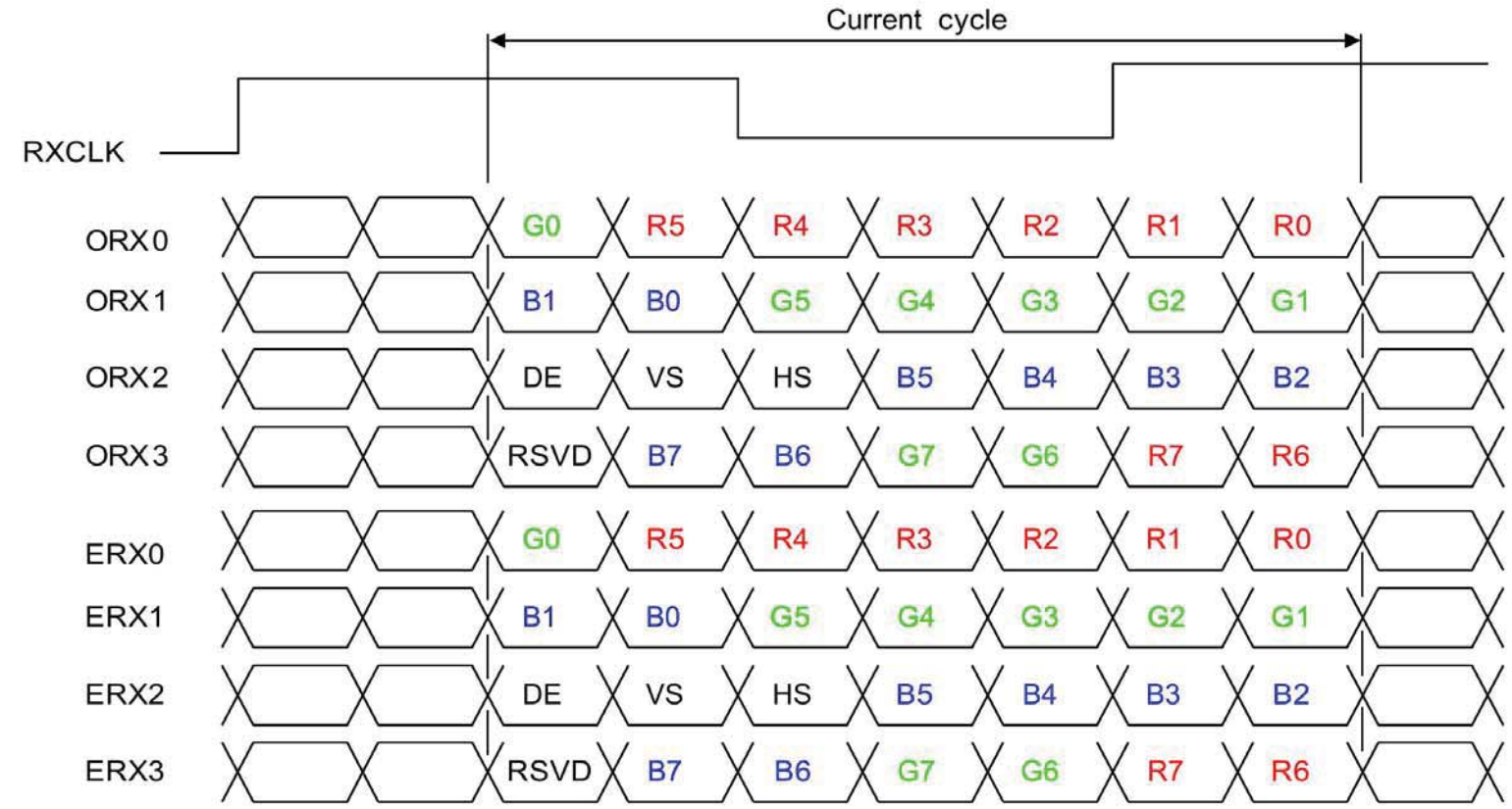
Note (2) LVDS cable impedance shall be 50 ohms per signal line or about 100 ohms per twist-pair line when it is used differentially.

5.5 LVDS INTERFACE

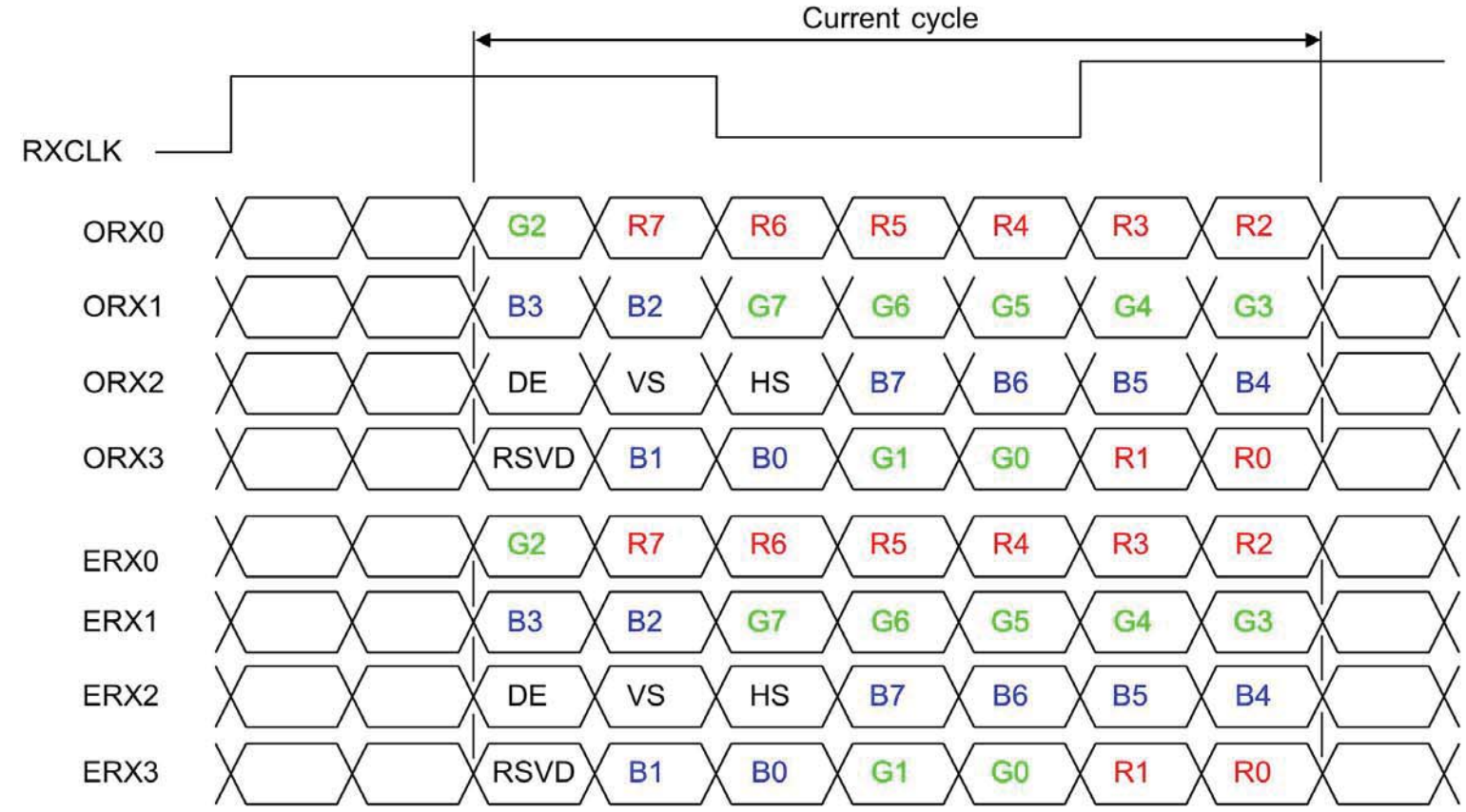
JEIDA Format : SELLVDS = L

VESA Format : SELLVDS = H or Open

VESA LVDS format



JEDIA LVDS format



5.6 COLOR DATA INPUT ASS IGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of the color versus data input.

Color		Data Signal																							
		Red								Green								Blue							
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red (253)	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red (255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale Of Green	Green (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	Green (2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green (253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
	Green (254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green (255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Gray Scale Of Blue	Blue (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue (2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue (253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue (254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue (255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

6. INTERFACE TIMING

6.1 INPUT SIGNAL TIMING SPECIFICATIONS (Ta = 25 ± 2 °C)

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
LVDS Receiver Clock	Frequency	F_{clkin} (=1/TC)	60	74.25	77	MHz	
	Input cycle to cycle jitter	T_{rcl}	-	-	200	ps	(2)
	Spread spectrum modulation range	F_{clkin_mod}	F_{clkin}-2%	-	F_{clkin}+2%	MHz	(3)
	Spread spectrum modulation frequency	F_{SSM}	-	-	200	KHz	
LVDS Receiver Data	Receiver Skew Margin	TRSKM	-400	-	400	ps	(4)

6.1.1 Timing spec for Frame Rate = 50Hz

Signal	Item		Symbol	Min.	Typ.	Max.	Unit	Note
Frame rate	2D mode		F_{r5}	47	50	53	Hz	
	3D mode		F_{r5}	50	50	50	Hz	(6)
Vertical Active Display Term	2D Mode	Total	Tv	1115	1125	1380	Th	Tv=Tvd+Tvb
		Display	Tvd	1080	1080	1080	Th	—
		Blank	Tvb	35	45	300	Th	—
	3D Mdoe	Total	Tv	1350			Th	(5), (7)
		Display	Tvd	1080			Th	
		Blank	Tvb	270			Th	
Horizontal Active Display Term	2D Mode	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
		Display	Thd	960	960	960	Tc	—
		Blank	Thb	90	140	190	Tc	—
	3D Mdoe	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
		Display	Thd	960	960	960	Tc	—
		Blank	Thb	90	140	190	Tc	—

6.1.2 Timing spec for Frame Rate = 60Hz

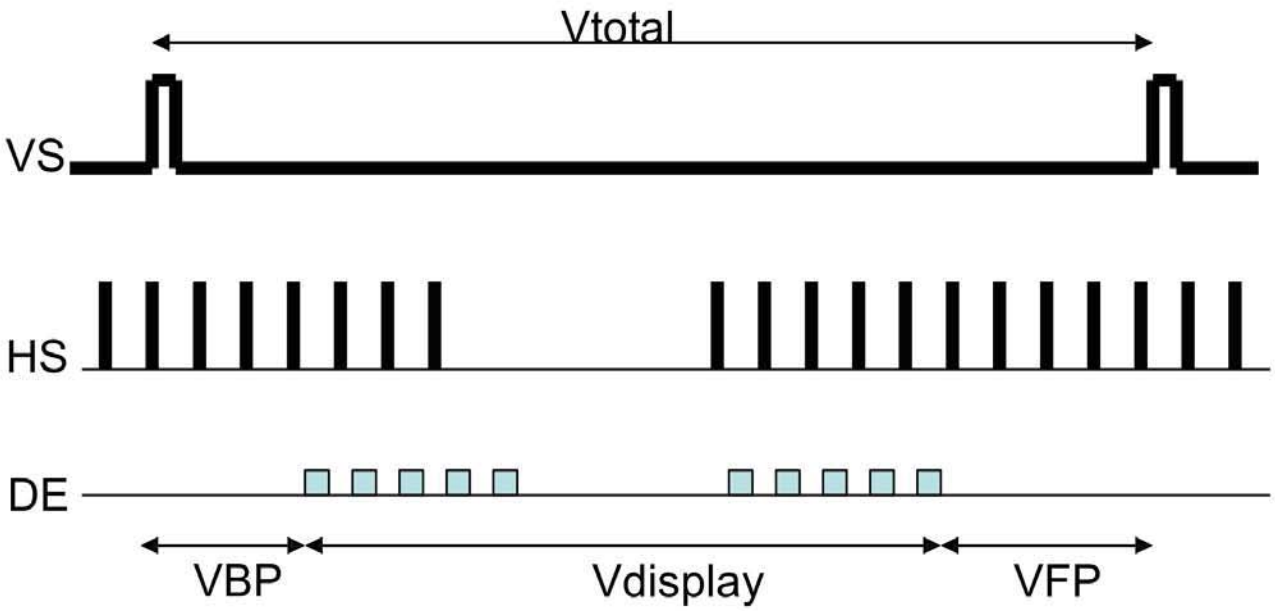
Signal	Item		Symbol	Min.	Typ.	Max.	Unit	Note
Frame rate	2D mode		F_{r6}	57	60	62.5	Hz	
	3D mode		F_{r6}	60	60	60	Hz	(6)
Vertical Active Display Term	2D Mode	Total	Tv	1115	1125	1380	Th	Tv=Tvd+Tvb
		Display	Tvd	1080	1080	1080	Th	—
		Blank	Tvb	35	45	300	Th	—
	3D Mdoe	Total	Tv	1125			Th	(5), (7)
		Display	Tvd	1080			Th	
		Blank	Tvb	45			Th	
Horizontal Active Display Term	2D Mode	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
		Display	Thd	960	960	960	Tc	—
		Blank	Thb	90	140	190	Tc	—
	3D Mdoe	Total	Th	1050	1100	1150	Tc	Th=Thd+Thb
		Display	Thd	960	960	960	Tc	—
		Blank	Thb	90	140	190	Tc	—

Note (1) Please make sure the range of pixel clock has follow the below equation:

$F_{clkin(max)} \geqq F_{r6} \times Tv \times Th$

$F_{r5} \times Tv \times Th \geqq F_{clkin(min)}$

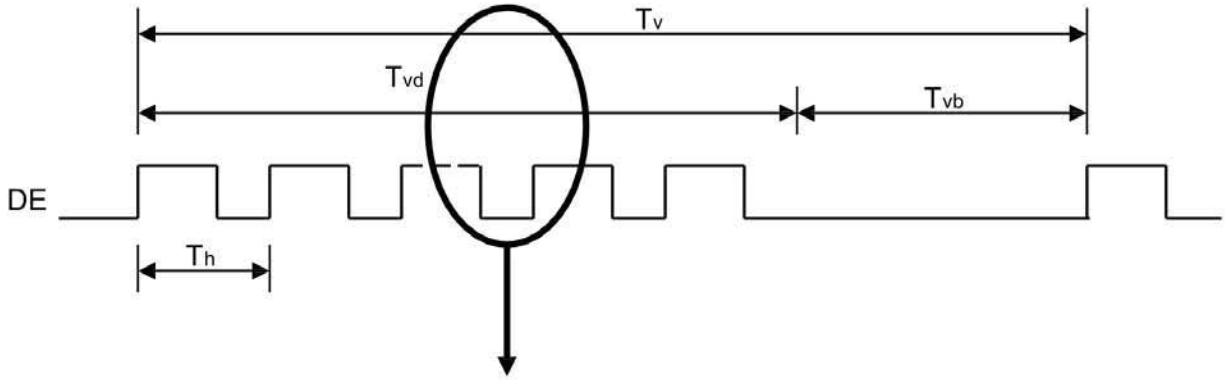
INPUT SIGNAL TIMING DIAGRAM

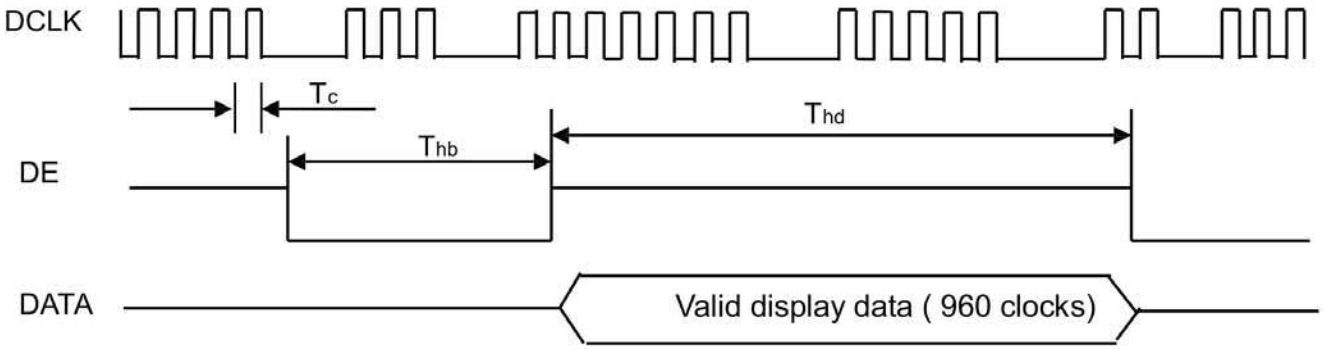


- VBP max : 150 line

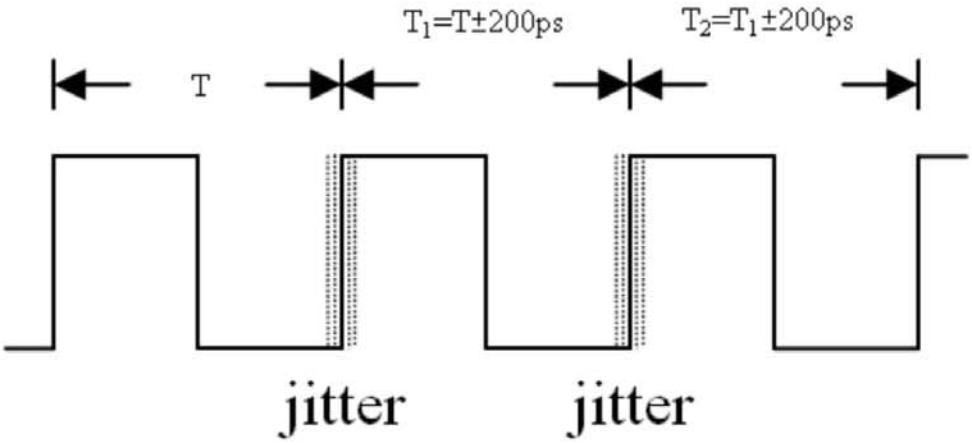
Suggest VBP = VFP = * (Vtotal - Vdisplay)

DE timing

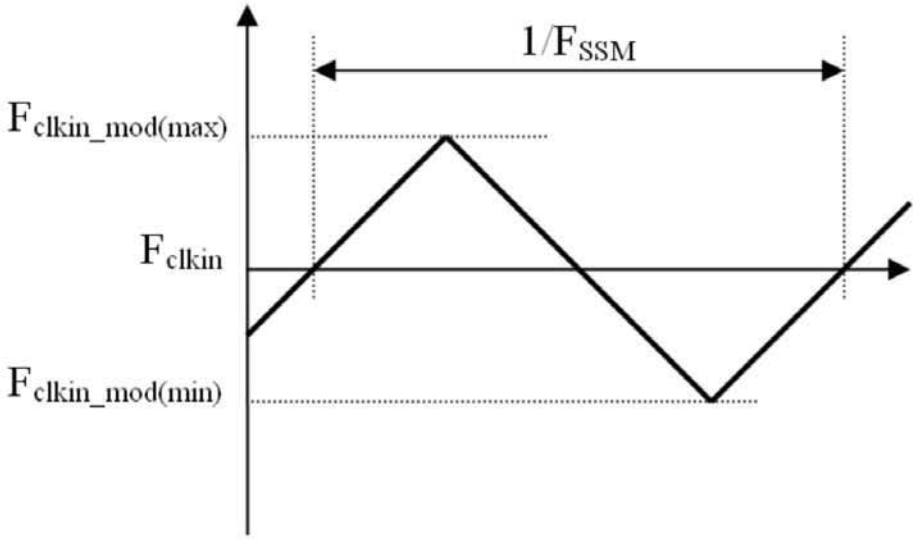




Note (2) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = I T_1 – TI

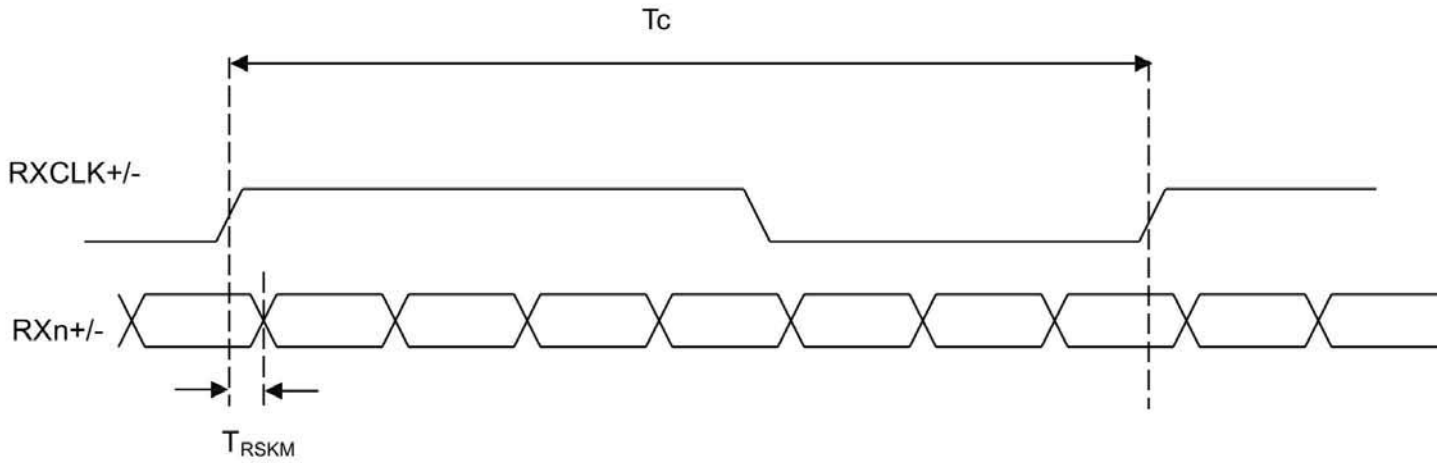


Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.



Note (4) LVDS receiver skew margin is defined and shown as below

LVDS RECEIVER INTERFACE TIMING DIAGRAM



Note (5) Please fix the Vertical timing (Vertical Total =1350 / Display =1080 / Blank = 270) in 50Hz 3D mode and Vertical timing (Vertical Total =1125 / Display =1080 / Blank = 45) in 60Hz 3D mode

Note (6) In 3D mode, the set up Fr5 and Fr6 in Typ. 3 Hz .In order to ensure that the electric function performance to avoid no display symptom.(Except picture quality symptom.)

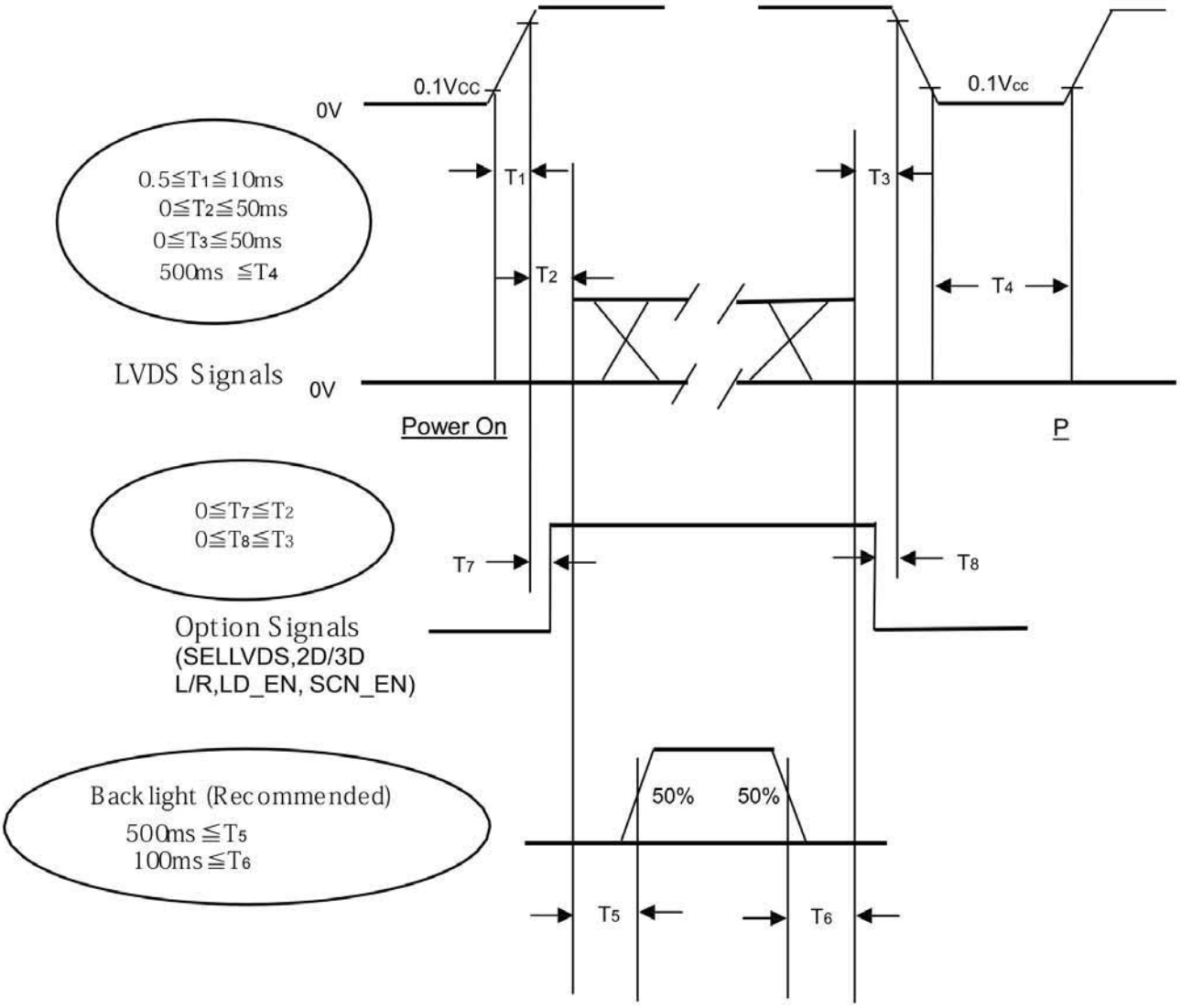
Note (7) In 3D mode, the set up Tv and Tvb in Typ. 30.In order to ensure that the electric function performance to avoid no display symptom.(Except picture quality symptom.)

6.2 POWER ON/OFF SEQUENCE

(Ta = 25 2 C)

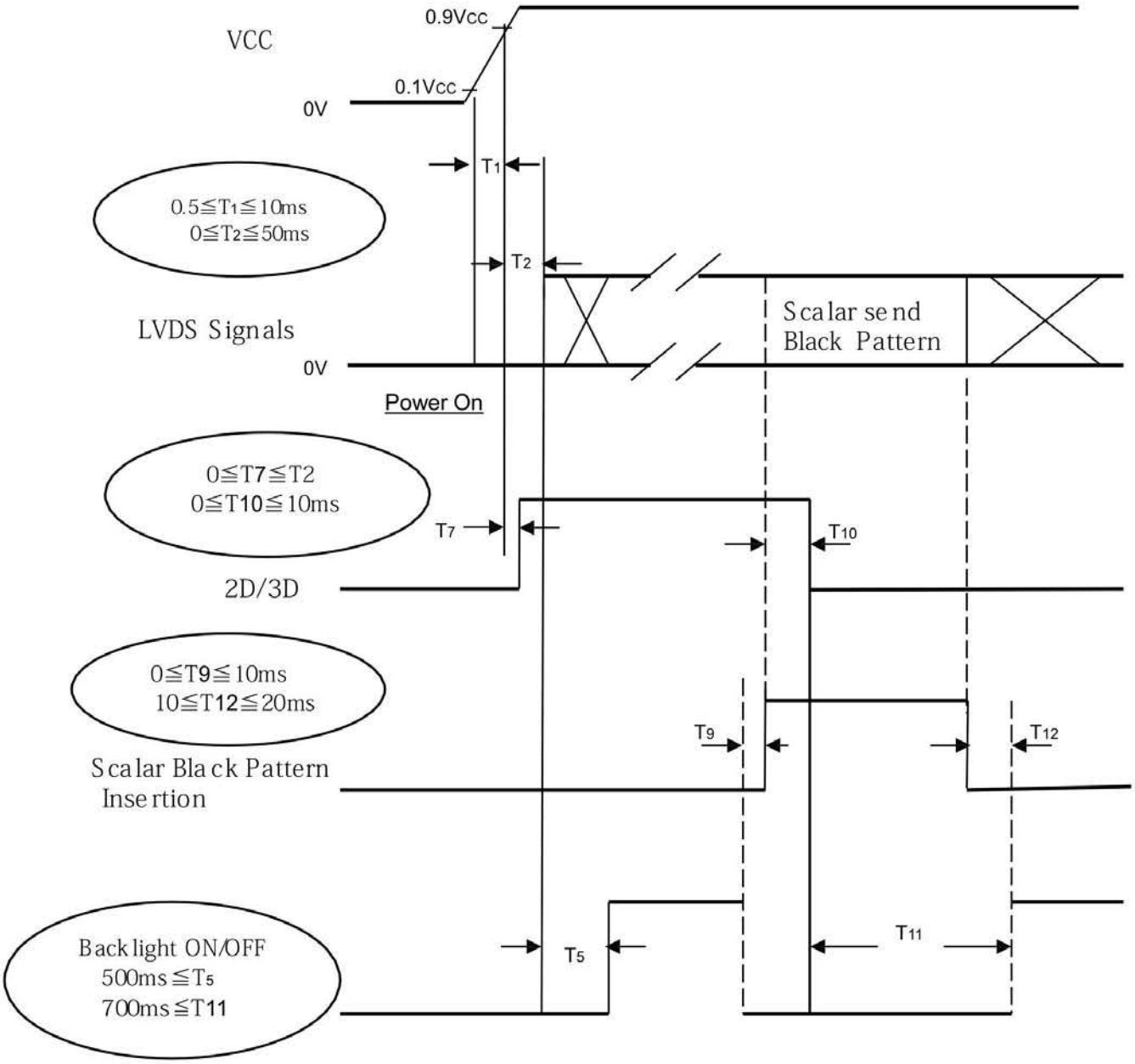
6.2.1 POWER ON/OFF SEQUENCE

To prevent a latch-up or DC operation of LCD module, the power on/off sequence should be as the diagram below.



Power ON/OFF Sequence

6.2.2 2D/3D MODE CHANGE SIGNAL SEQUENCE WITHOUT VCC TURN OFF AND TURN ON



Note (1) The supply voltage of the external system for the module input should follow the definition of Vcc.

Note (2) Apply the LED voltage within the LCD operation range. When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.

Note (3) In case of Vcc is in off level, please keep the level of input signals on the low or high impedance. If T2<0,that maybe cause electrical overstress failure.

Note (4) T4 should be measured after the module has been fully discharged between power off and on period.

Note (5) Interface signal shall not be kept at high impedance when the power is on.

Note (6) When 2D/3D mode is changed, TCON will insert black pattern internally. During black insertion, TCON would load required optical table and TCON parameter setting. The black insertion time should be longer than 650ms because TCON must recognize 2D or 3D format and set the correct parameter.

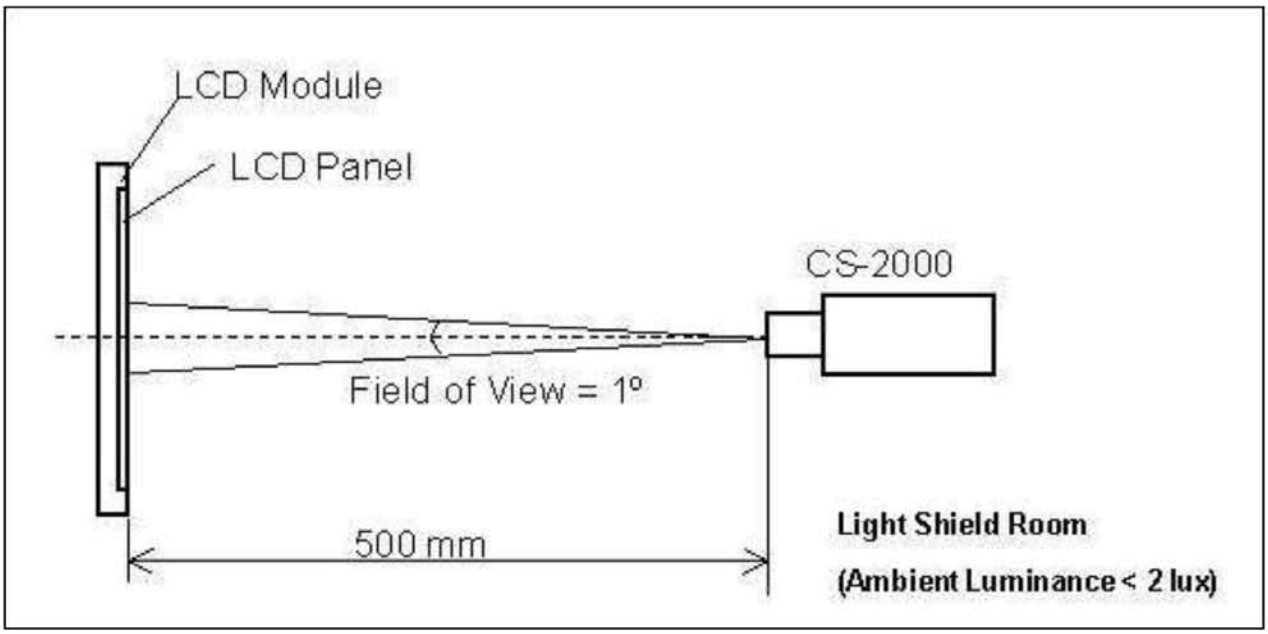
Note (7) 2D/3D switching time should be larger than 500ms.

7. OPTICAL CHARACTERISTICS

7.1 TEST CONDITIONS

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25 2	°C
Ambient Humidity	Ha	50 10	%RH
Supply Voltage	V_{CC}	12V	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Current	I_L	115	mA

Local Dimming Function should be Disable before testing to get the steady optical characteristics (According to 5.1 CNF1 Connector Pin Assignment, Pin no. “42”)



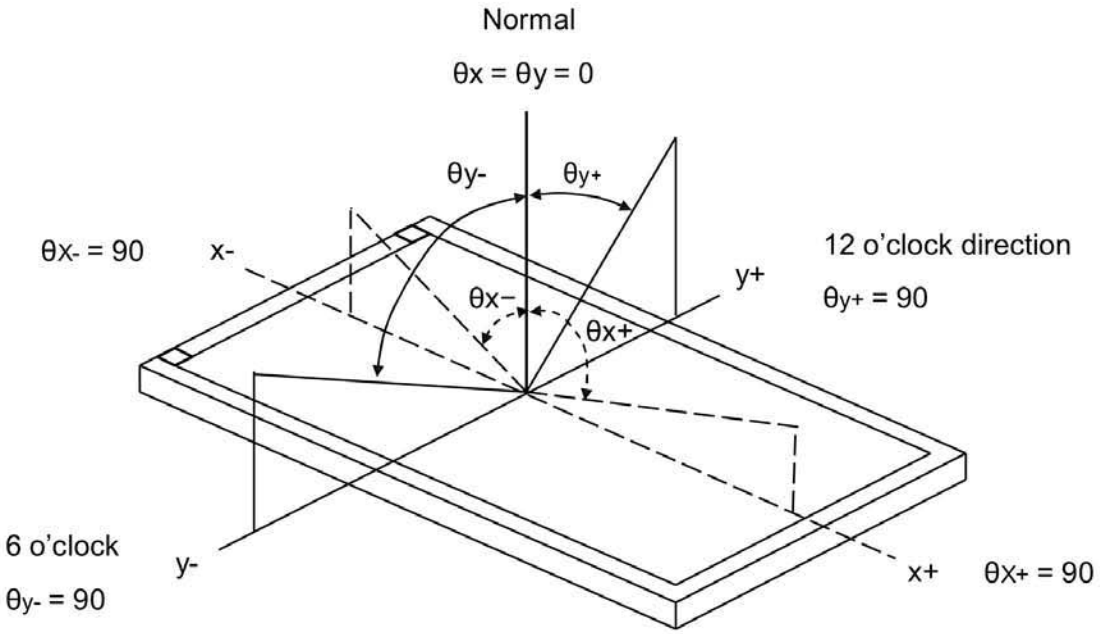
7.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 7.2. The following items should be measured under the test conditions described in 7.1 and stable environment shown in 7.1.

Item		Symbol		Condition	Min.	Typ.	Max.	Unit	Note
Contrast Ratio		CR			3500	5000	-	-	Note(2)
Response Time		Gray to gray				6	12	ms	Note(3)
Center Luminance of White		L_C	2D		300	350	-	cd/m^2	Note(4)
			3D			85	-	cd/m^2	Note(8)
White Variation		δW					1.3	-	Note(6)
Cross Talk		CT	2D		-	-	4	%	Note(5)
			3D-W		-	4	-	%	Note(8)
			3D-D		-	11	-	%	Note(8)
Color Chromaticity	Red	Rx		$\theta_x=0°, \theta_Y=0°$ Viewing angle at normal direction	Typ.-0.03	0.645	Typ.+0.03	-	
		Ry				0.330		-	
	Green	Gx				0.300		-	
		Gy				0.595		-	
	Blue	Bx				0.145		-	
		By				0.055		-	
	White	Wx				0.280		-	
		Wy				0.290		-	
	Correlated color temperature					9800		K	
	Color Gamut	C.G.			-	72	-	%	NTSC
Viewing Angle	Horizontal	θ_x+		CR?20	80	88	-	Deg.	(1)
		θ_x-			80	88	-		
	Vertical	θ_Y+			80	88	-		
		θ_Y-			80	88	-		
Transmission direction of the upper polarizer		Φ_{up-P}				90		Deg.	(7)

Note (1) Definition of Viewing Angle (θx, θy):

Viewing angles are measured by Autronic Conoscope Cono-80.



Note (2) Definition of Contrast Ratio (CR) :

The contrast ratio can be calculated by the following expression.

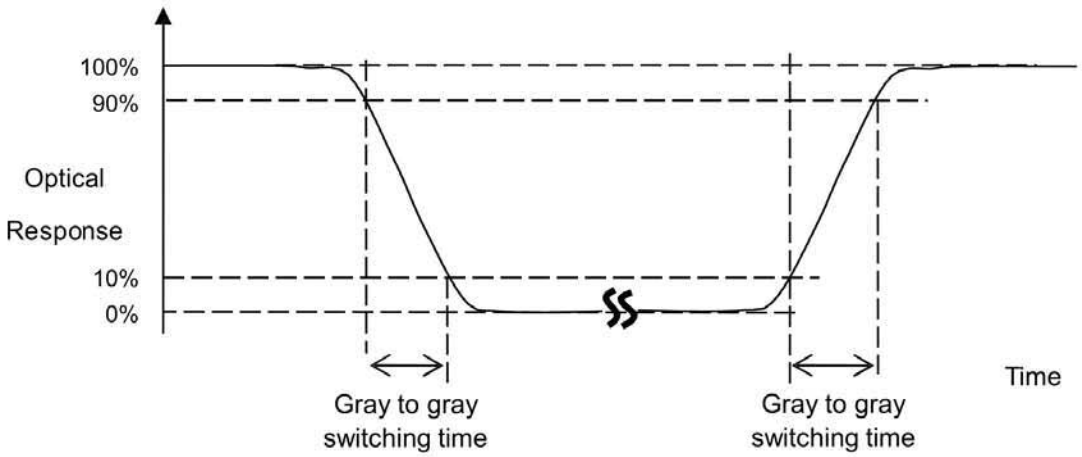
$$\text{Contrast Ratio (CR)} = \frac{\text{Surface Luminance of L255}}{\text{Surface Luminance of L0}}$$

L255: Luminance of gray level 255

L 0: Luminance of gray level 0

CR = CR (5), where CR (X) is corresponding to the Contrast Ratio of the point X at the figure in Note (6).

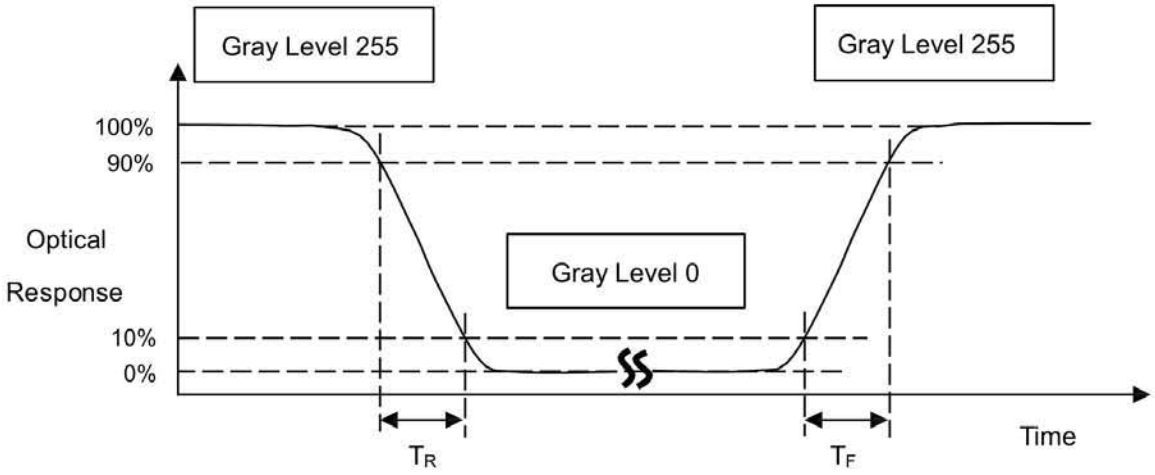
Note (3) Definition of Gray-to-Gray Switching Time:



The driving signal means the signal of gray level 0, 124, 252, 380, 508, 636, 764, 892 and 1023.

Gray to gray average time means the average switching time of gray level 0, 124, 252, 380, 508, 636, 764, 892 and 1023 to each other.

Definition of Response Time (T_R, T_F):



Note (4) Definition of Luminance of White (L_C):

Measure the luminance of gray level 1023 at center point.

L_C = L (5), where L (x) is corresponding to the luminance of the point X at the figure in Note (6).

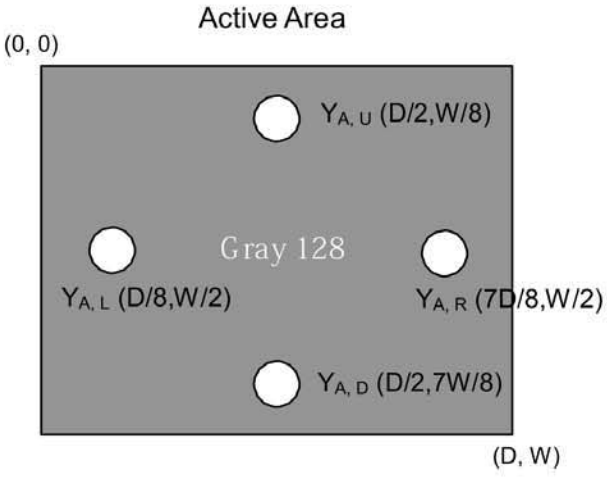
Note (5) Definition of Cross Talk (CT):

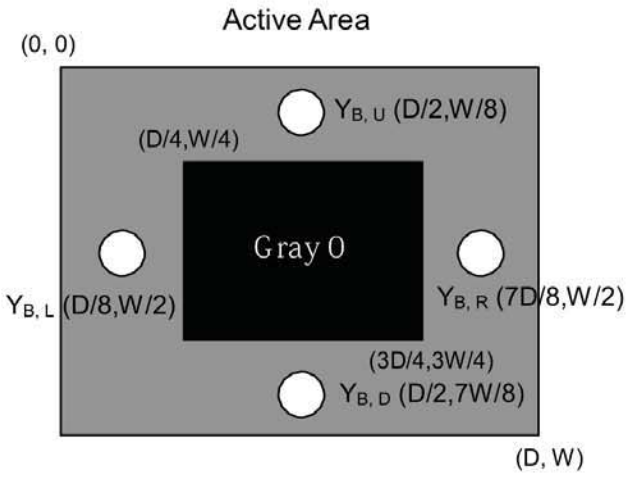
$CT = | Y_B - Y_A | / Y_A \quad 100\ (\%)$

Where:

YA = Luminance of measured location without gray level 0 pattern (cd/m2)

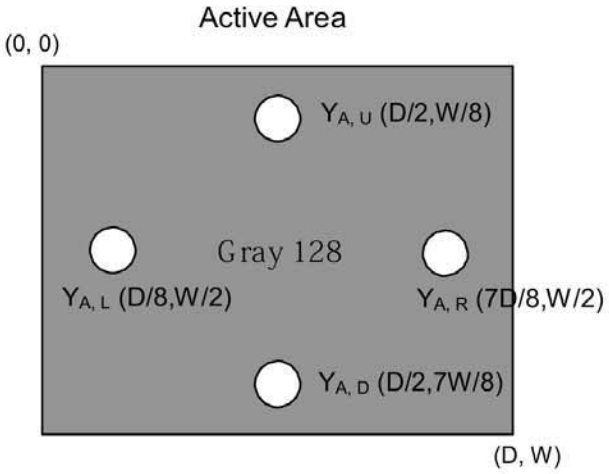
YB = Luminance of measured location with gray level 0 pattern (cd/m2)

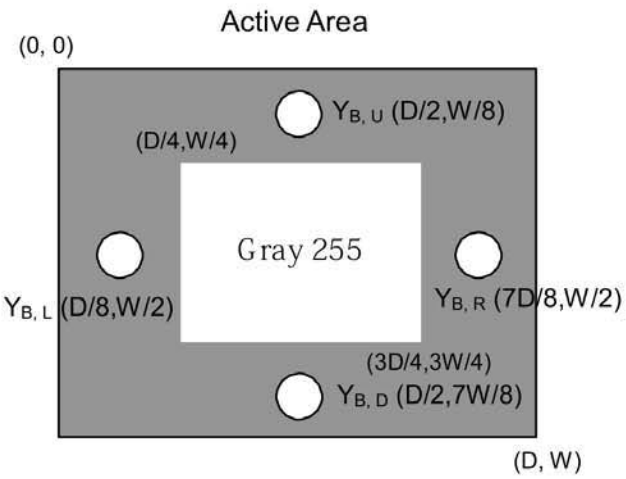




YA = Luminance of measured location without gray level 255 pattern (cd/m2)

YB = Luminance of measured location with gray level 255 pattern (cd/m2)

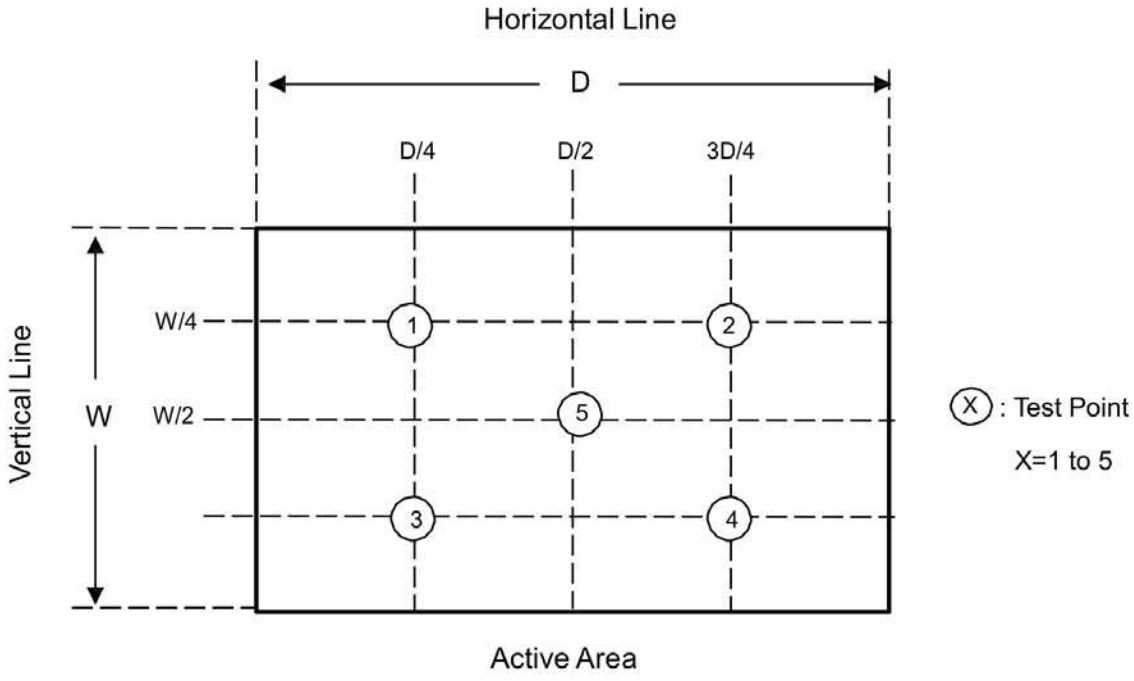




Note (6) Definition of White Variation (δW):

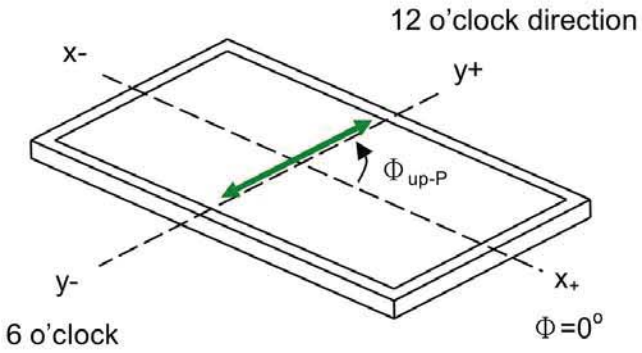
Measure the luminance of gray level 255 at 5 points

δW = Maximum [L (1), L (2), L (3), L (4), L (5)] / Minimum [L (1), L (2), L (3), L (4), L (5)]



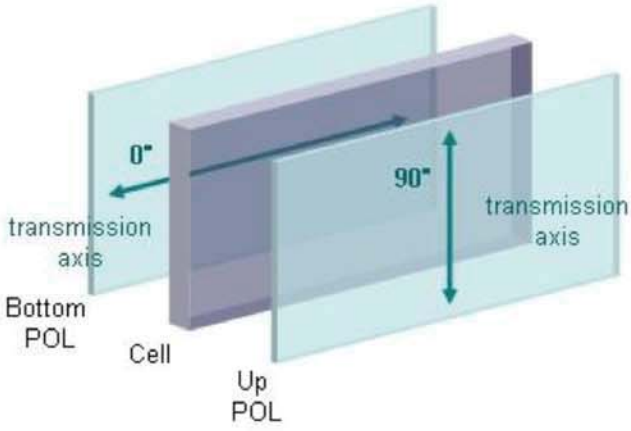
Note (7) This is a reference for designing the shutter glasses of 3D application.

Definition of the transmission direction of the up polarizer(Φ_{up-P}) on LCD Module:

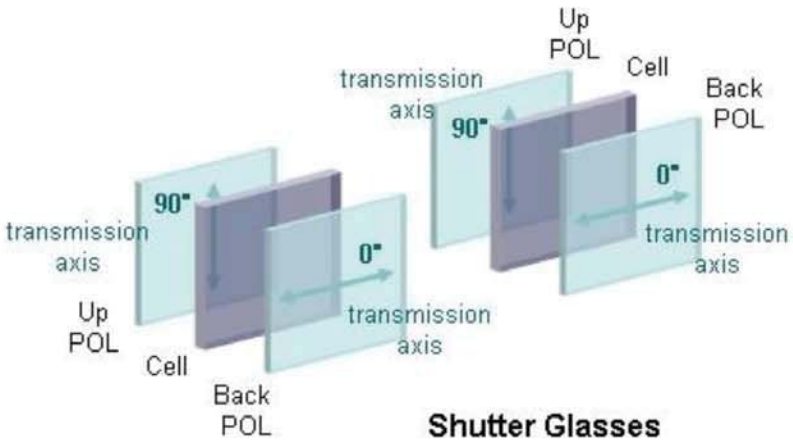


Up Polarizer

The transmission axis of the front polarizer of the shutter glasses should be parallel to this panel transmission direction to get a maximum 3D mode luminance.



LCD Module

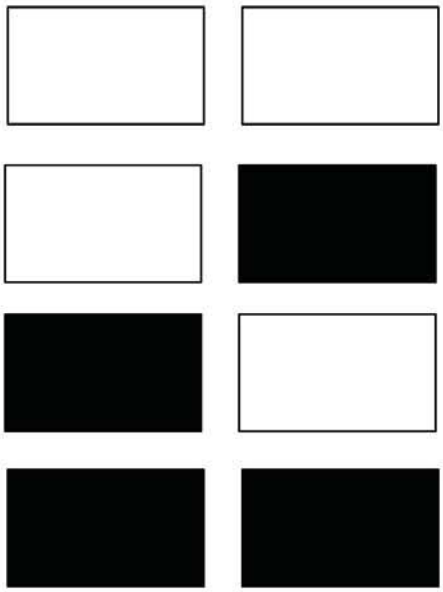


Shutter Glasses

Note(8) Definition of the 3D mode performance (measured under 3D mode, use CMI's shutter glass):

a. Test pattern

Left eye image and right eye image are displayed alternated



WW

Left eye image: W255; Right eye image: W255

WB

Left eye image: W255; Right eye image: W0

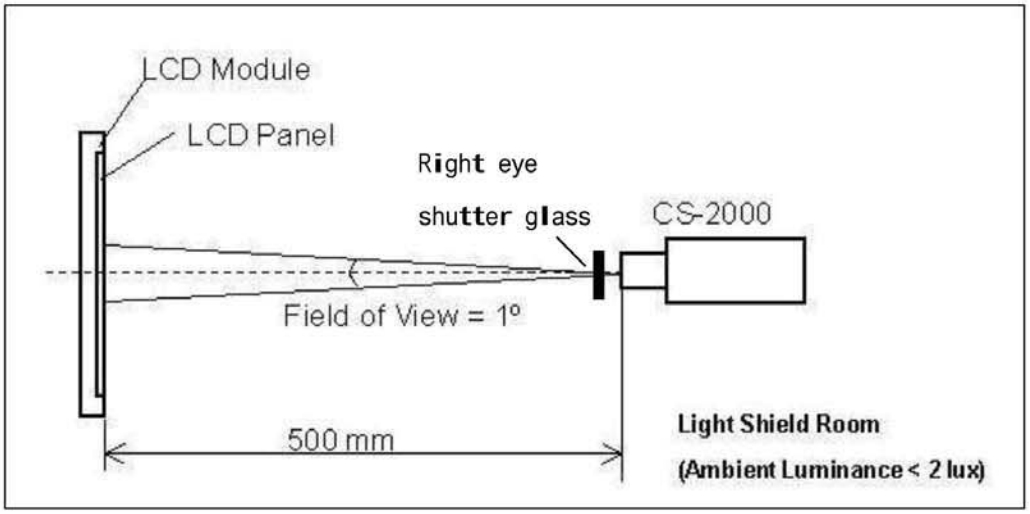
BW

Left eye image: W0; Right eye image: W255

BB

Left eye image: W0; Right eye image: W0

b. Measurement setup



Shutter glasses are well controlled under suitable timing, and measure the luminance of the center point of the panel through the right eye glass. The transmittance of the glass should be larger than 40.0% under 3D mode operation.

The luminance of the test pattern "WW", denoted L(WW); the luminance of the test pattern "WB", denoted L(WB); the luminance of the test pattern "BW", denoted L(BW); the luminance of the test pattern "BB", denoted "L(BB)

c. Definition of the Center Luminance of White, Lc (3D) : L(WW)

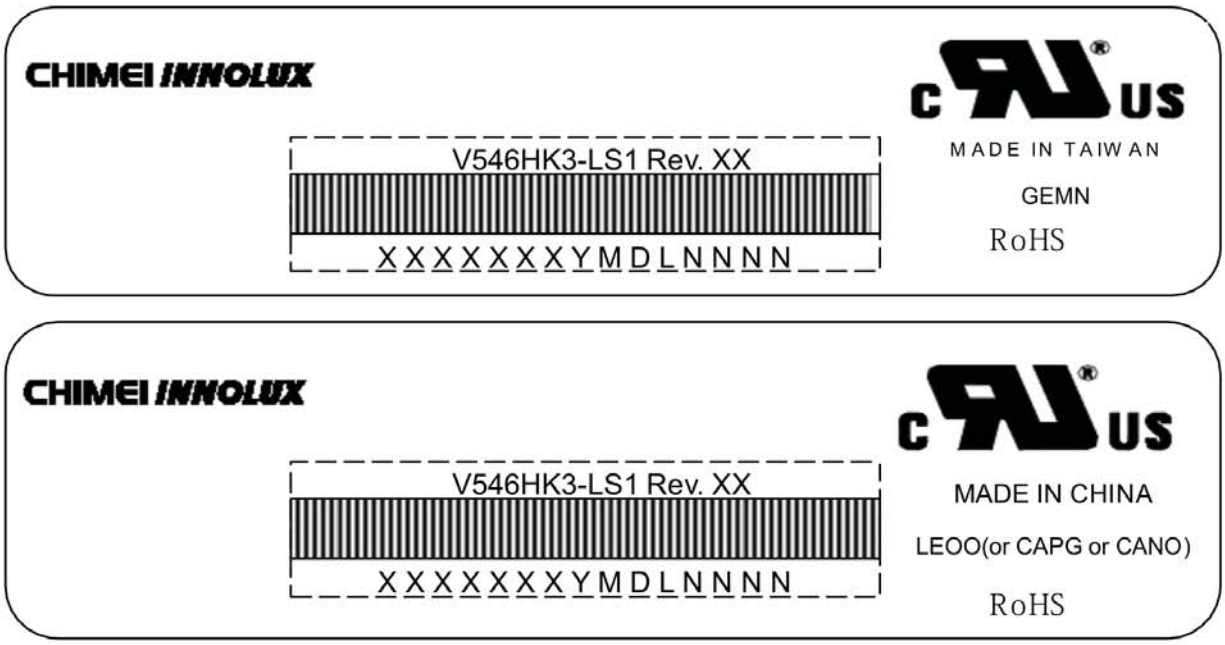
d. Definition of the 3D mode white crosstalk, CT (3D-W) : $CT(3D-W) \equiv \left| \frac{L(WB) - L(BB)}{L(WW) - L(BB)} \right|$

e. Definition of the 3D mode dark crosstalk, CT (3D-D) : $CT(3D-D) \equiv \left| \frac{L(WW) - L(BW)}{L(WW) - L(BB)} \right|$

8. DEFINITION OF LABELS

8.1 CMI MODULE LABEL

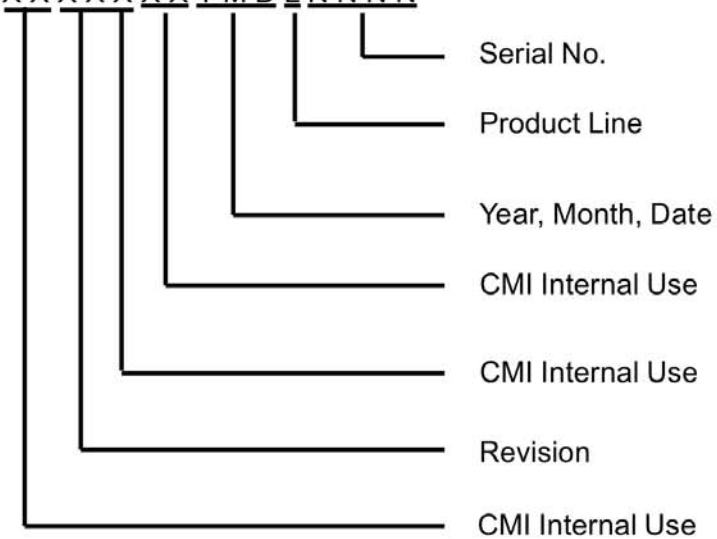
The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



Model Name: V546H1-LS1

Revision: Rev. XX, for example: A0, A1… B1, B2… or C1, C2…etc.

Serial ID: X X X X X X Y M D L N N N N



Serial ID includes the information as below:

Manufactured Date:

Year : 2001=1, 2002=2, 2003=3, 2004=4…2010=0, 2011=1, 2012=2…

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for 1st to 31st, exclude I ,O, and U.

Revision Code : Cover all the change

Serial No. : Manufacturing sequence of product

Product Line : 1 → Line1, 2 → Line 2, …etc.

9. Packaging

9.1 PACK ING SP EC IFICATIONS

(1) 16 LCD TV modules / 1 Box

(2) Box dimensions: 1150(L) X 1440 (W) X 850 (H)

(3) Weight: approximately 265 Kg (16 modules per box)

9.2 PACK ING MET HOD

Figures 9-1 and 9-2 are the packing method

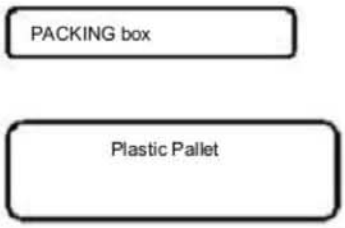
ITEM	Specification	Remark
LCD Packingg	16ea / Box (Packing-Pallet(Packing Pallet Box)	1. --kg/LCD(16ea) 2. --kg/CARTON BOX(1ea)
Wood Pallet	1 Box/Pallet	Pallet Weight : -kg
Packing Direction	Vertical	L1150mm*W1440mm* H850Hmm
Pallet Size	H x V x Height	L1150mm x W1440mm x H150mm
Pallet Weight	-kg	Pallet(--kg) + CARTON BOX (--kg x 1ea) + Module(--kg x 16eaModule(--kg

8.2 PACKING METHOD

(1) Packing Form

Corrugated fiberboard box as shock absorber

(2) Packing Method



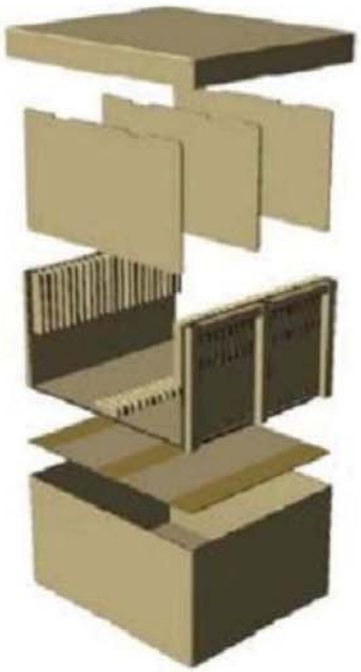


Figure.9-1 packing method

10.Internal Standa rt

10.1 ASS EMBLY AND HANDLING PRECAUTIONS

(1) UL 60950-1, UL 60065: Standard for Safety of Information Technology Equipment Including electrical Business Equipment.

(2) IEC 60950-1:2005, IEC 60065:2001+ A1:2005 ; Standard for Safety of International Electrotechnical Commission.

(3) EN 60950-1:2006+ A11:2009, EN60065:2002 + A1:2006 + A11:2008; European Committee for Electrotechnical Standardization (CENELEC), EUROPEAN STANDARD for Safety of Information Technology Equipment Including Electrical Business Equipment.

10.2 EMC

(1) ANSI C63.4 Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHZ to 40GHZ. “ Anerican National standards Institute(ANSI)

(2) C.I.S.P.R “ Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment. “ International Special committee on Radio Interference.

(3) EN 55022 “ Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment. “European Committee for Electortechnical Standardization.(CENELEC)

11. PRECAUTIONS

11.1 ASSEMBLY AND HANDLING PRECAUTIONS

(1) Do not apply rough force such as bending or twisting to the module during assembly.

(2) It is recommended to assemble or to install a module into the user's system in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.

(3) Do not apply pressure or impulse to the module to prevent the damage of LCD panel and backlight.

(4) Always follow the correct power-on sequence when the LCD module is turned on. This can prevent the damage and latch-up of the CMOS LSI chips.

(5) Do not plug in or pull out the I/F connector while the module is in operation.

(6) Do not disassemble the module.

(7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.

(8) Moisture can easily penetrate into LCD module and may cause the damage during operation.

(9) High temperature or humidity may deteriorate the performance of LCD module. Please store LCD modules in the specified storage conditions.

(10) When ambient temperature is lower than 10 C, the display quality might be reduced. For example, the response time will become slow, and the starting voltage of LED will be higher than that of room temperature.

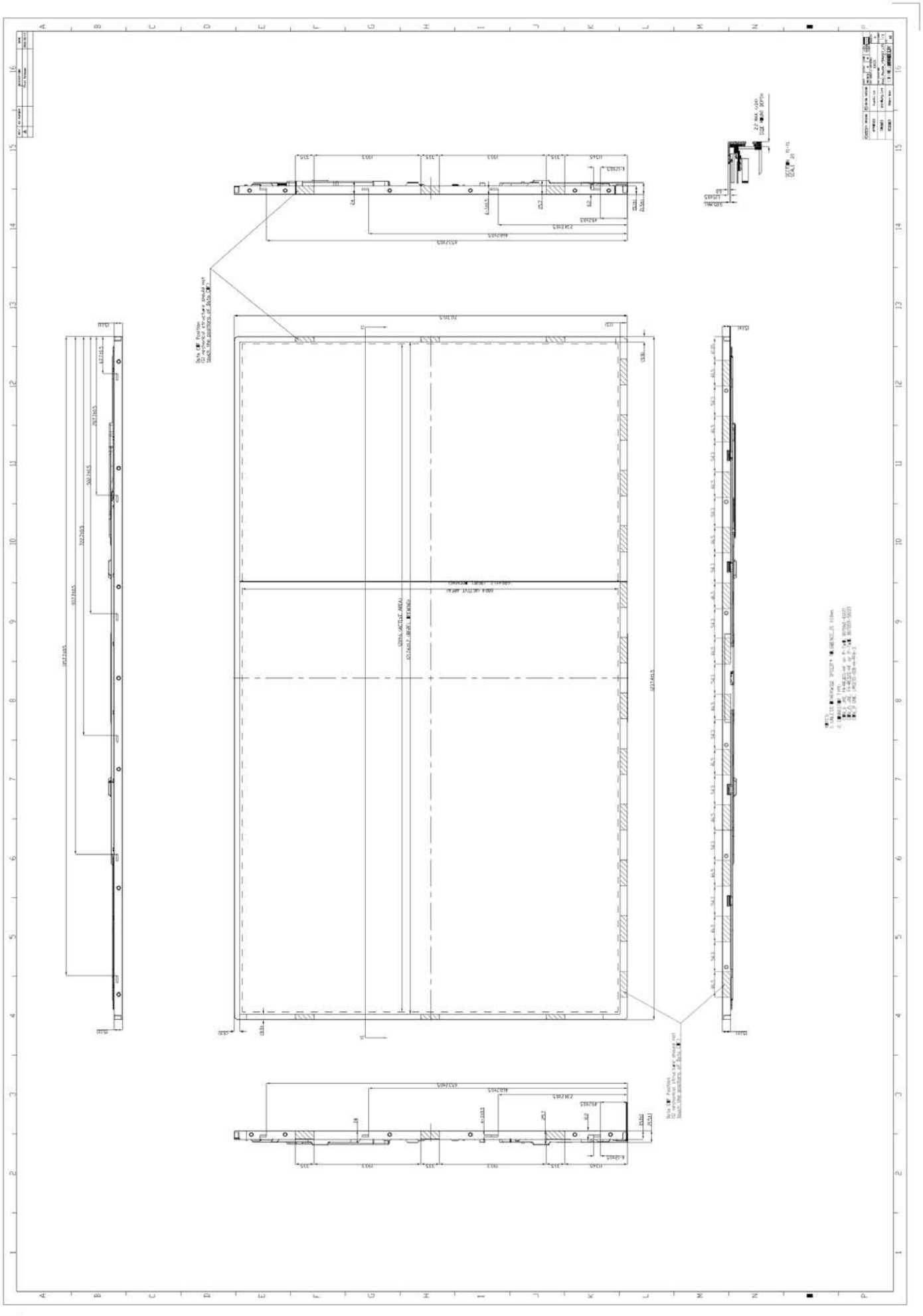
11.2 SAFETY PRECAUTIONS

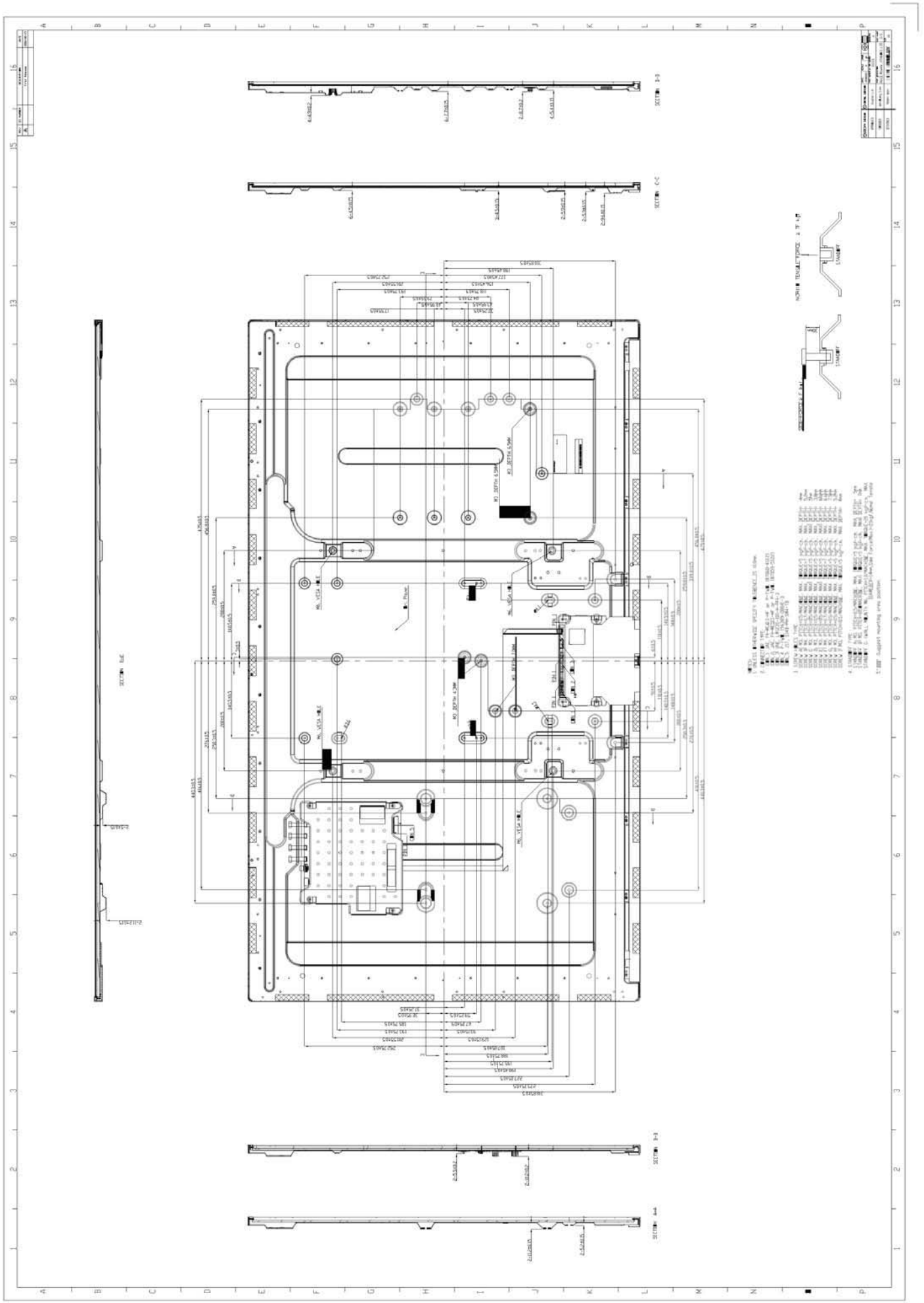
(1) The startup voltage of a backlight is over 1000 Volts. It may cause an electrical shock while assembling with the inverter. Do not disassemble the module or insert anything into the backlight unit.

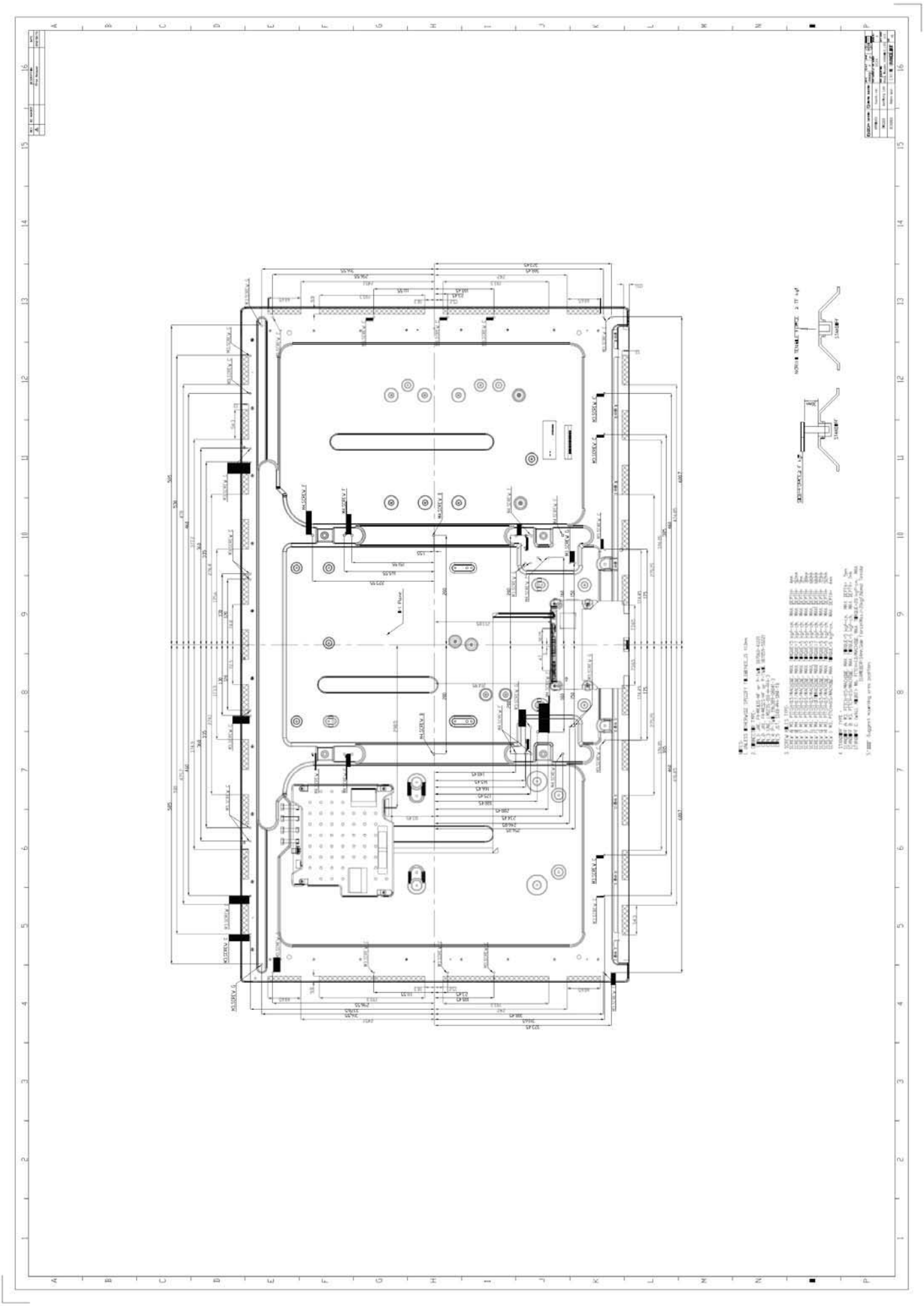
(2) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.

(3) After the module's end of life, it is not harmful in case of normal operation and storage.

12. MECHANICAL CHARACTERISTIC







Appendix A
Local Dimming demo function

A.1 I2C address and write command

Device address: 0xe0

Register address: 0x65

Command data: 0x16 0x00 0x00 0x00 0x00 0x00: Local Dimming demo mode OFF (Note 1)

0x16 0x00 0x00 0x00 0x00 0x01: Local Dimming demo mode ON (Demo in right half screen) (Note 2)

Preamble data: 0x26 0238

I2C data:

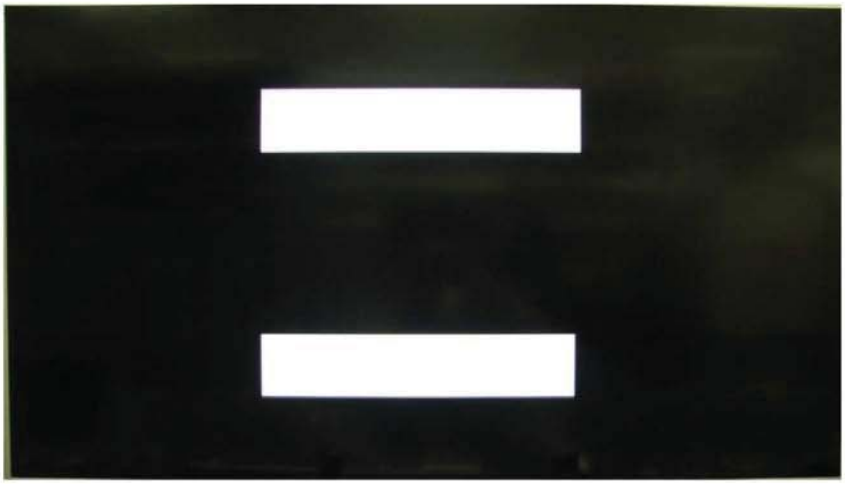
	Device Address		Preamble data		Preamble data	
START	11100000 (0xE0)	ACK	00100110 (0x26)	ACK	00111000 (0x38)	ACK

	Register Address		Command Data		Command Date	
	01100101 (0x65)	ACK	00010110 (0x16)	ACK	00000000 (0x00)	ACK

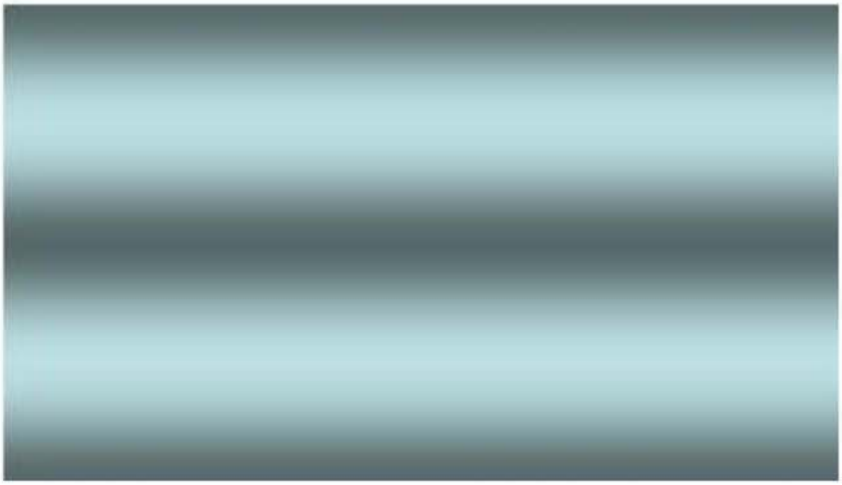
	Command Date		Command Data		Command Date	
	00000000 (0x00)	ACK	00000000 (0x00)	ACK	00000000 (0x00)	ACK

Command Date	
00000001 (0x01)	STOP

Note 1: Local Dimming demo OFF



Note 2: Local Dimming demo ON



A.2 I2C timing

Symbol	Parameter	Min.	Max.	Unit
t_{SU-STA}	Start setup time	250	-	ns
t_{HD-STA}	Start hold time	250	-	ns
t_{SU-DAT}	Data setup time	80	-	ns
t_{HD-DAT}	Data hold time	0	-	ns
t_{SU-STO}	Stop setup time	250	-	ns
t_{BUF}	Time between Stop condition and next Start condition	500	-	ns